State-of-the-Art Mobile Charging: Topologies, Technologies and Performance

PSMA Industry Session IS05: Mobile Applications

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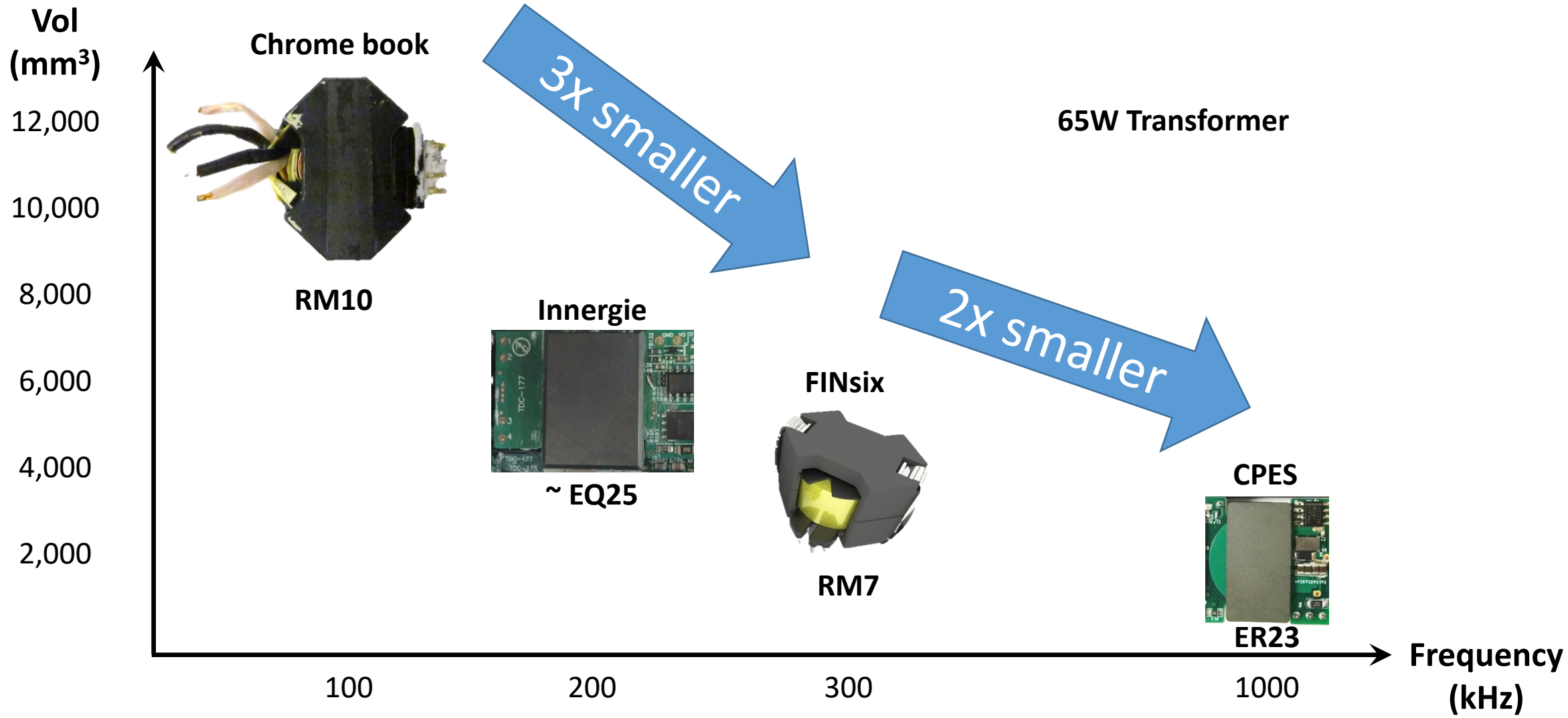
March 29th 2017

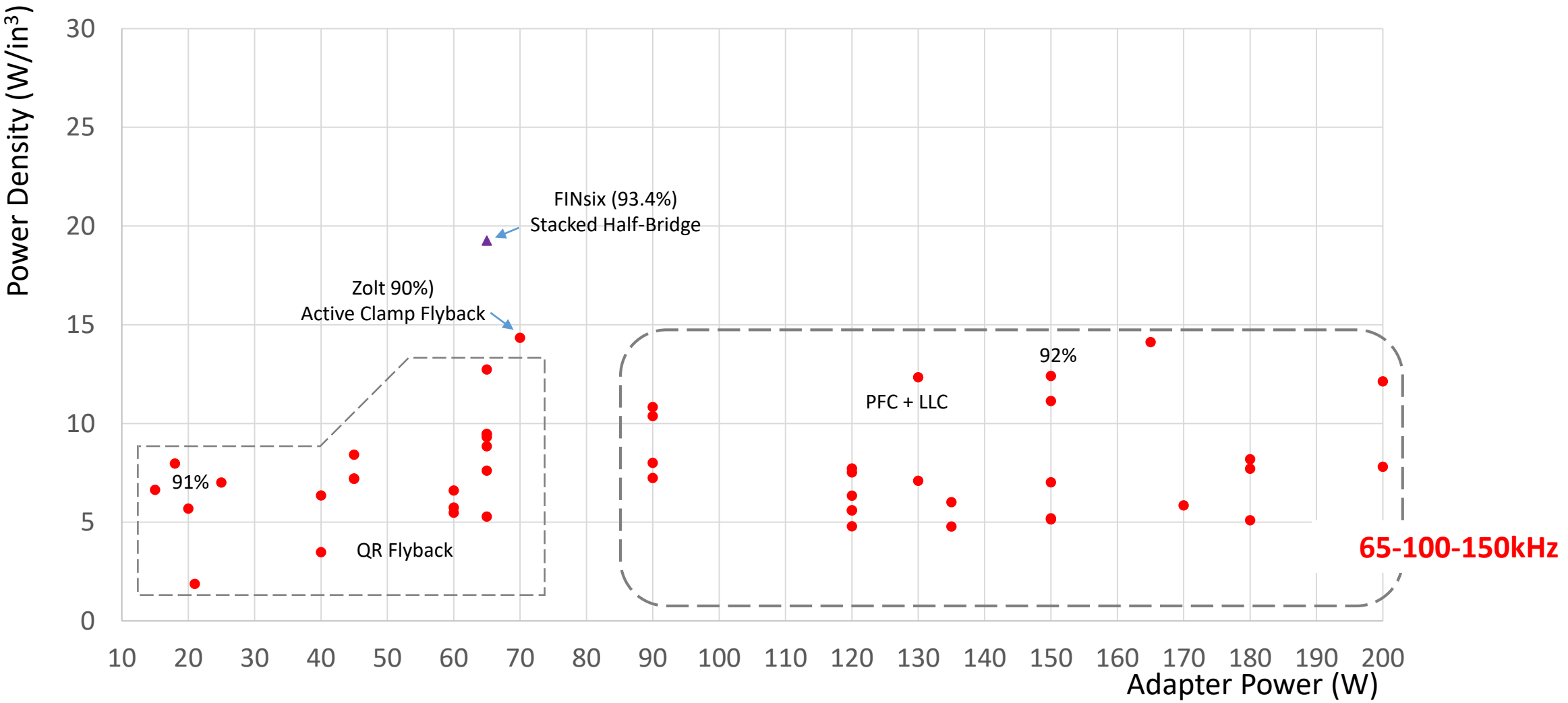
Getting to Fast…

- Topology / technique
  - Hard-switch → Soft switch (ZVS)
  - New technology enables new topologies to be commercially viable
- Switch technology
  - Si Bipolar → Si FET → Discrete / Cascoded GaN → GaN Power ICs
- Magnetic Materials
  - New compounds / alloys, optimized for high frequency

Fast → Small


Vol (mm³)
12,000
10,000
8,000
6,000
4,000
2,000
Chrome book
RM10
3x smaller
Innergie
~ EQ25
65W Transformer
2x smaller
FINsix
RM7
CPES
ER23
100
200
300
1000
Frequency (kHz)

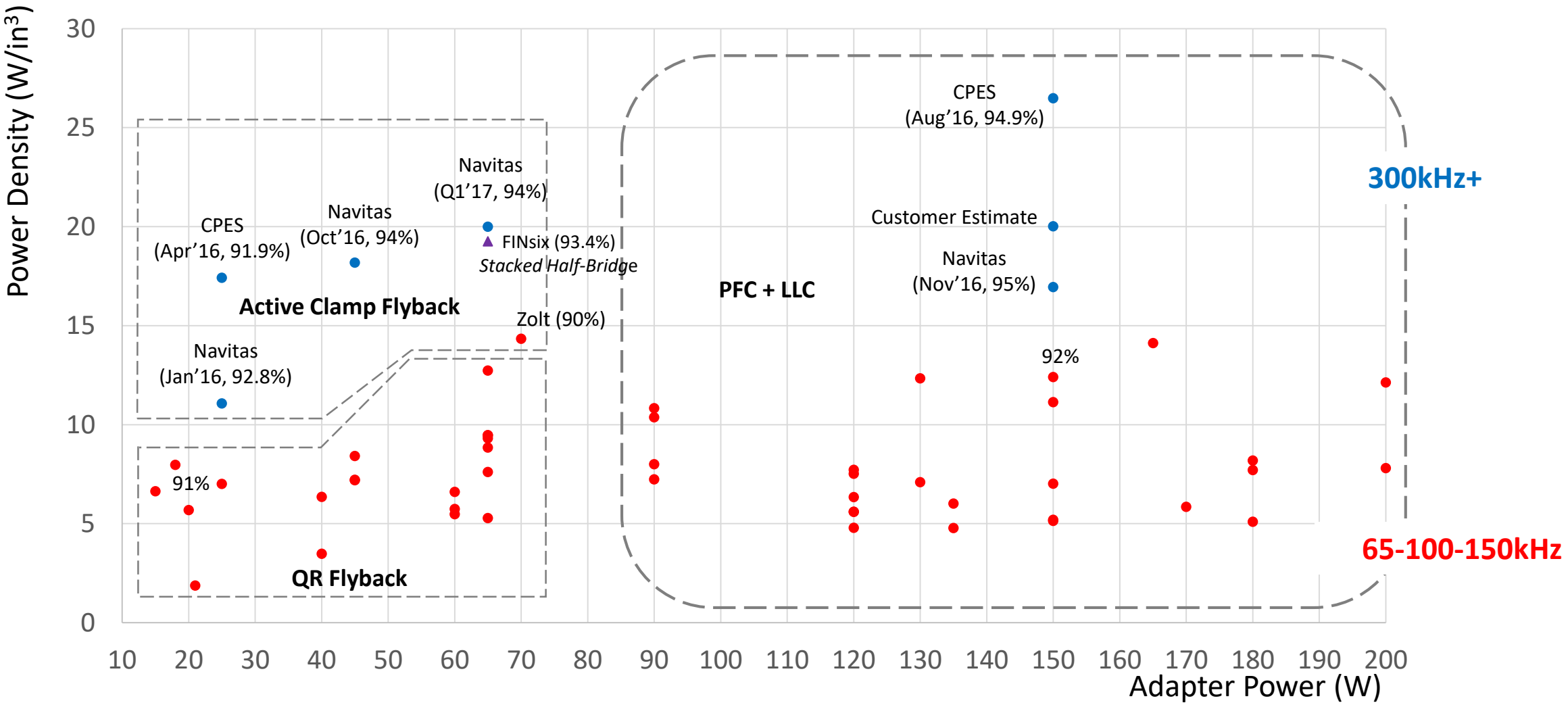
Adapter Density 2016:



Efficiency at full load, $120V_{AC}$

Adapter Density 2017:

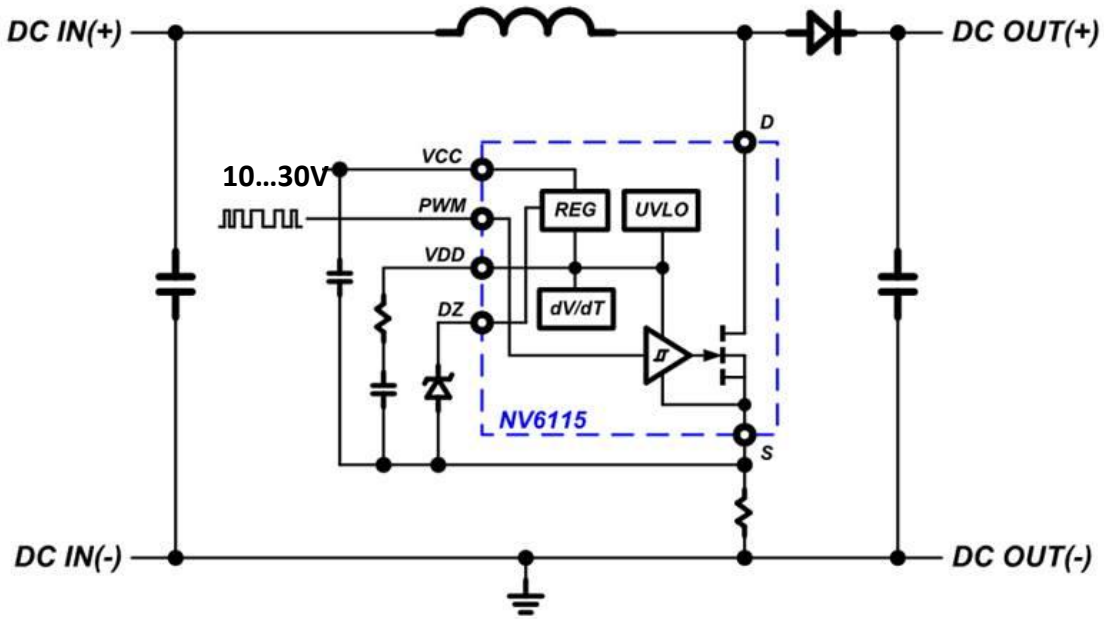
Frequency Drives Size

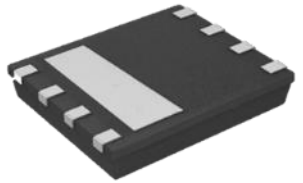


Efficiency at full load, $120V_{AC}$

GaN Power IC: High-Speed FET, Driver & More

- Proprietary AllGaN™ technology
- **Monolithic** integration of GaN FET, GaN Driver, GaN Logic
- 650 V eMode
- 20x lower drive loss than silicon (<35 mW at 1 MHz)
- Driver impedance matched to power device
- Very fast (prop delay and turn-on/off of 10-20 ns)
- Zero inductance turn-off loop
- High dV/dt immunity (200 V/ns) with control
- Digital input
- Complete layout flexibility



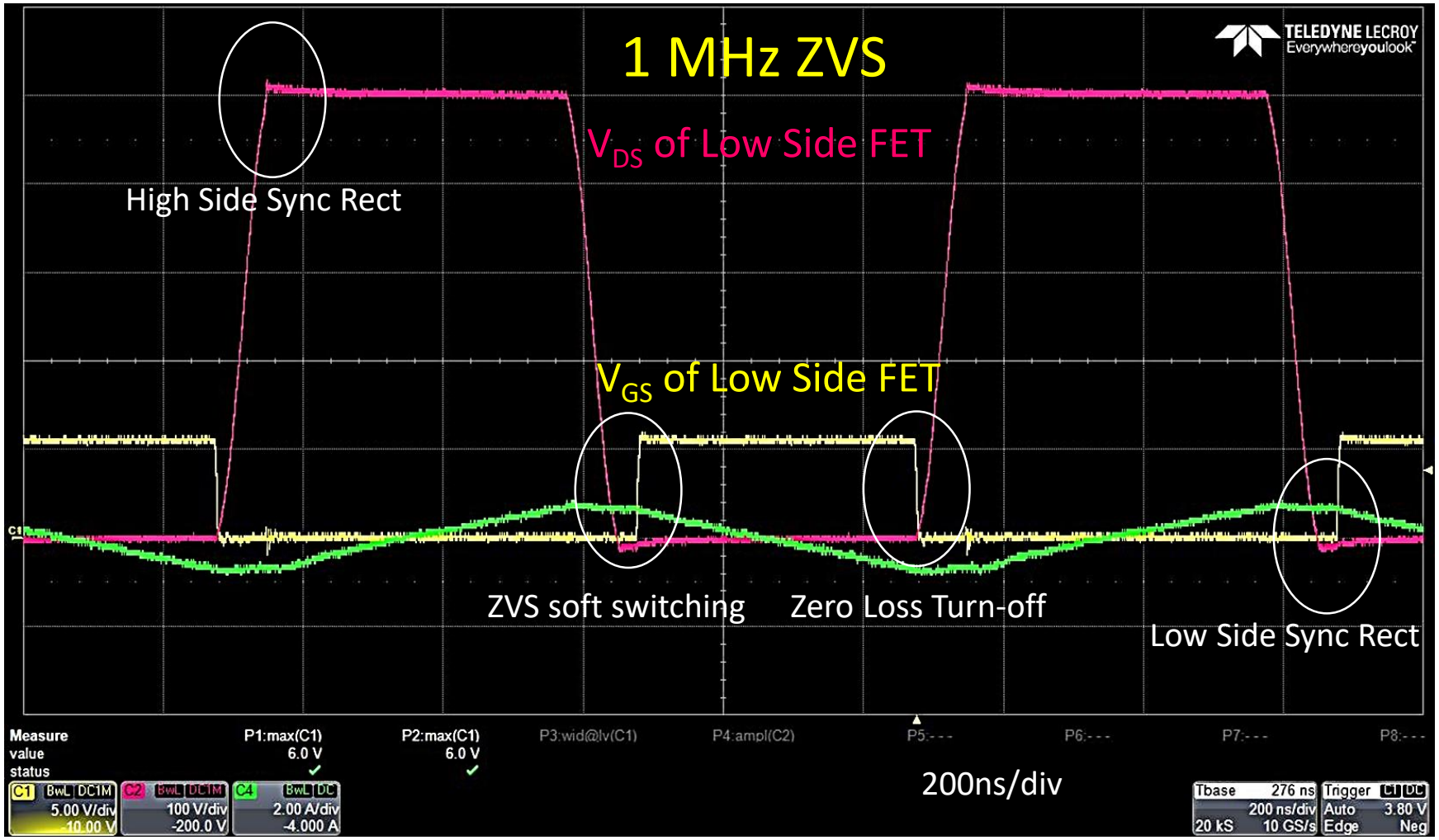


QFN 5x6mm

D. Kinzer, S. Oliver "Monolithic HV GaN Power ICs" in *IEEE PELS Power Electronics Magazine*, vol. 3, no. 3, pp. 14-21, September 2016

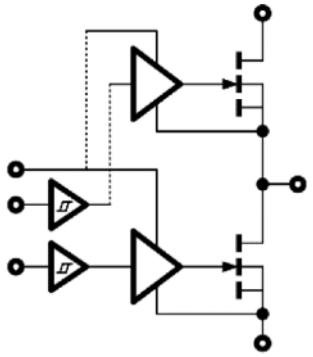
GaN Power IC – *Fast & Efficient*

- 500 V Switching
- No overshoot / spike
- No oscillations
- ‘S-curve’ transitions
- Zero Loss Turn-on
- Zero Loss Turn-off
- Sync Rectification
- High frequency
- Small, low cost magnetics



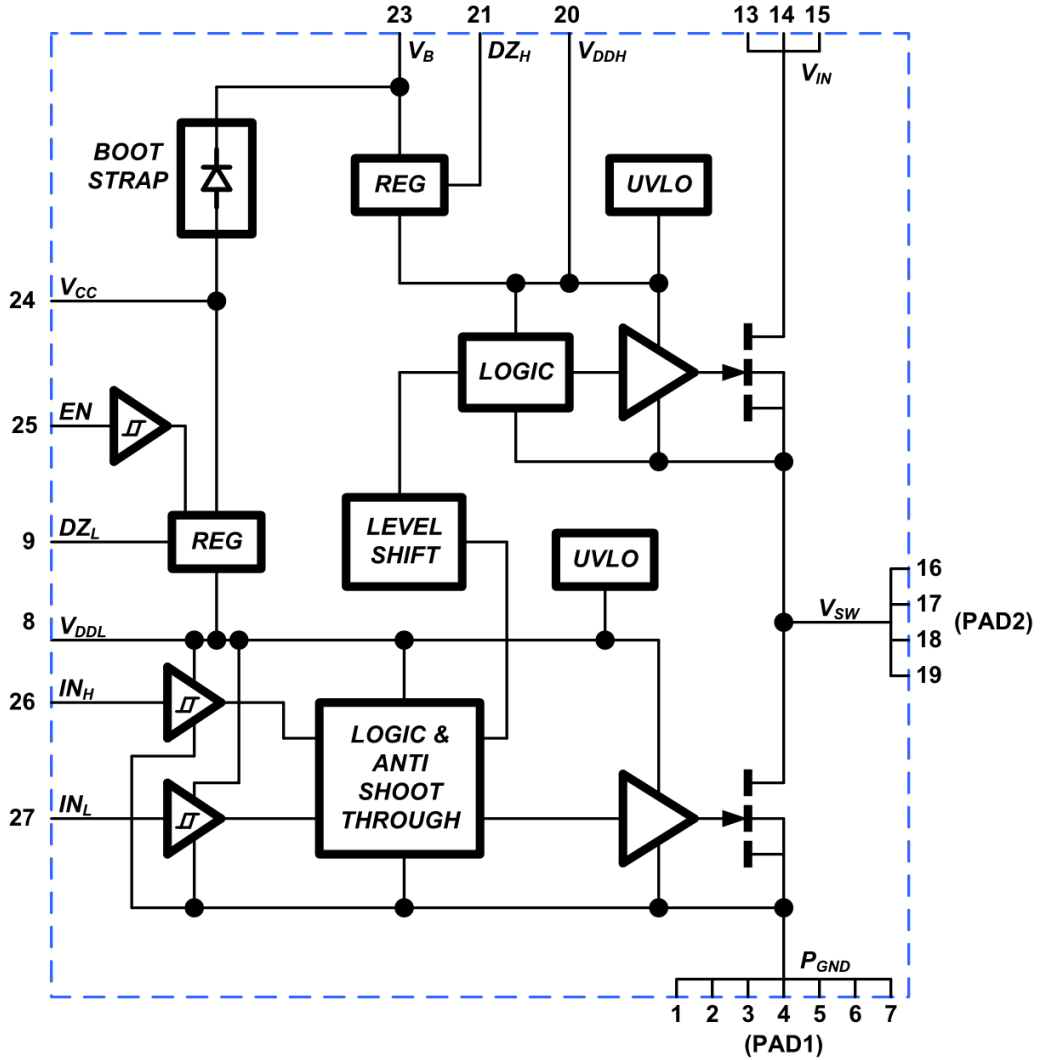
Half-Bridge iDrive GaN Power IC

PQFN 6x8 mm



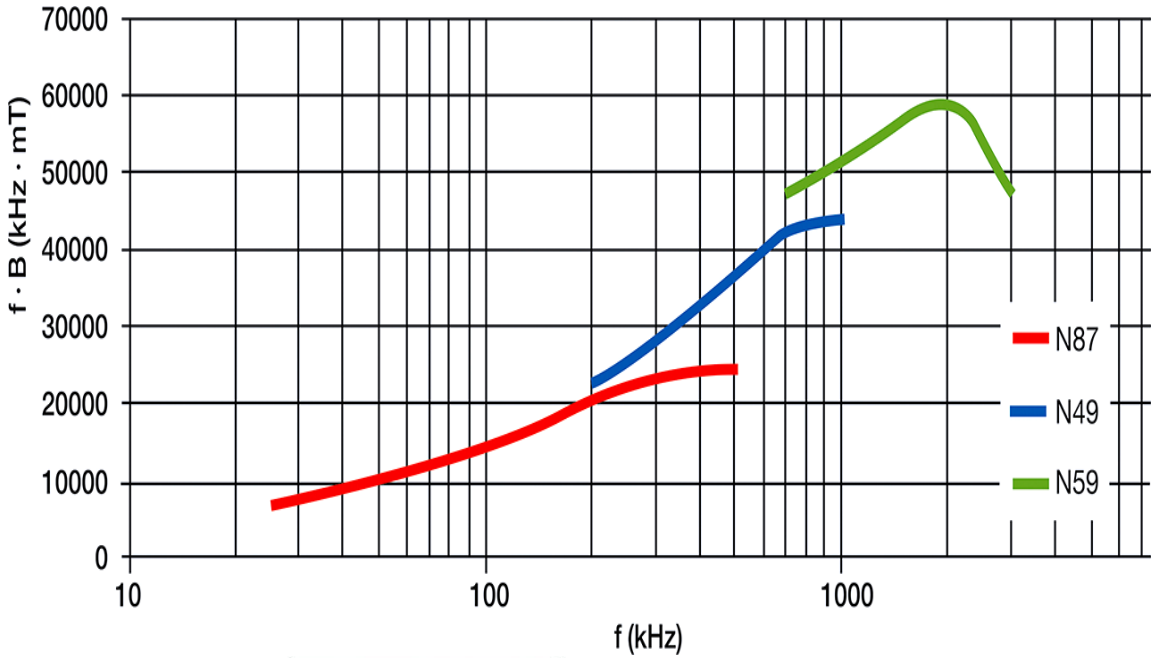
Simplified Schematic

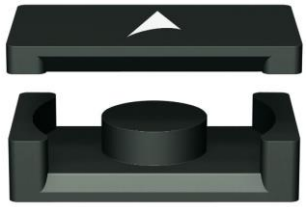
- Internal level-shift, bootstrap
- Range from (2x) 160-560 mOhm (650V)
- Single component
- Ground-referenced control
- Active Clamp Flyback, Half-Bridge, LLC, etc.



High Frequency Magnetics

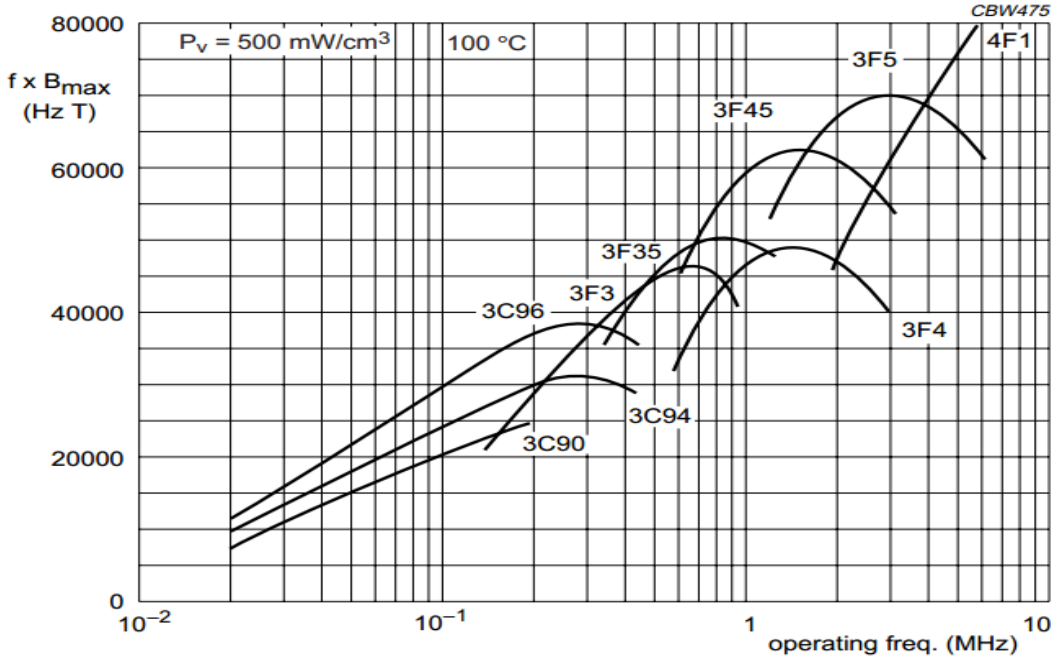
N59 optimized for 2MHz

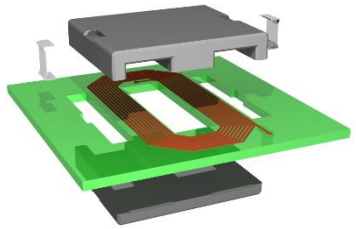




TDK

3F & 4F up to 10MHz





PRECISION INCORPORATED

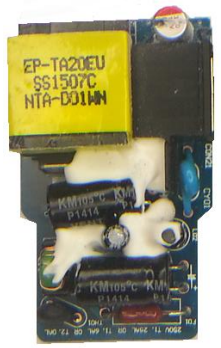
TDK/EPCOS N59/PC200 : https://en.tdk.eu/tdk-en/374108/tech-library/articles/products---technologies/products---technologies/low-losses-at-high-frequencies/1206400
Hitachi Metals ML91S : http://www.hitachi-metals.co.jp/e/press/news/2016/n0404.html
ACME P61 : http://www.acme-ferrite.com.tw/en/material.asp , http://www.acme-ferrite.com.tw/investor/m3.pdf

Fast Chargers … *going "GaN Fast"*

3x Fast Charging with 50% Energy Savings

Navitas

Existing Si-based 15W



100 kHz
Up to 6.5 W/in³
88%

AllGaN™ 2016 25W

2x Faster Charging

300-500 kHz
11 W/in³
>92%

AllGaN™ 2017 25W

3x Faster Charging

25W 5W

>1 MHz
17.5 W/in³
>95%

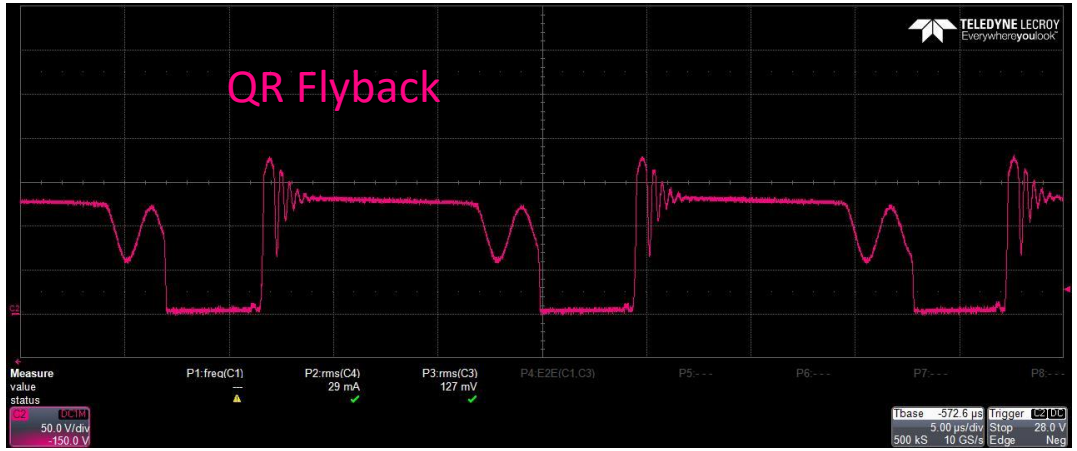
Smartphones & Tablets

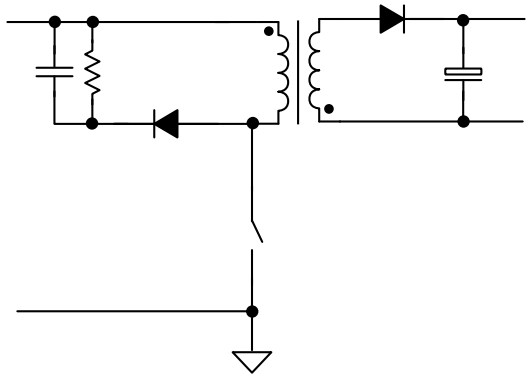
Fast-charging Drones

AR / VR & Wearables

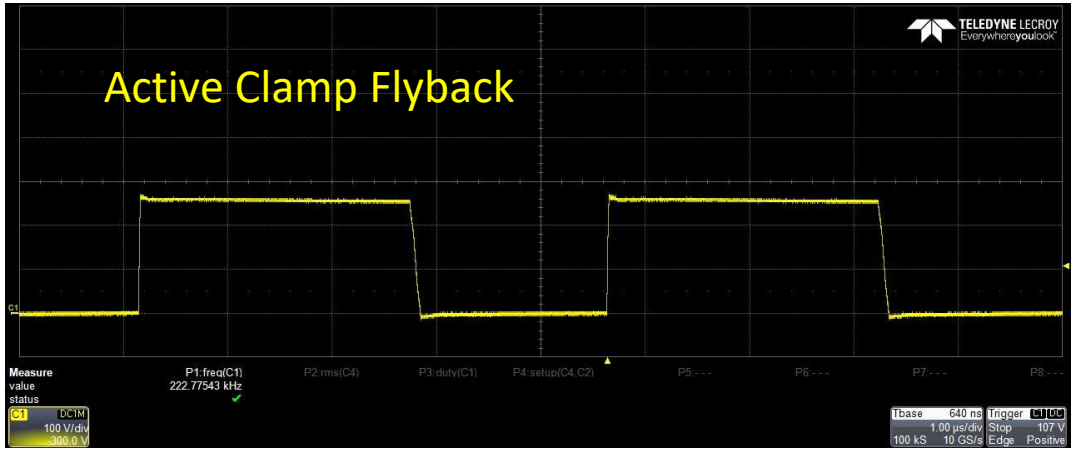
2016: Navitas; **2017**: Xiucheng Huang, "High Frequency GaN Characterization and Design Considerations," Ph.D Dissertation, Dept. Electr. Eng., Virginia Tech., Blacksburg, VA, USA, 2016.

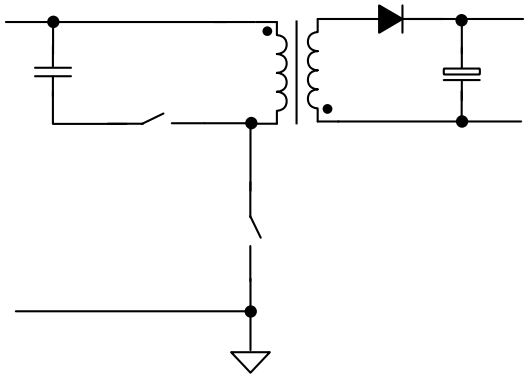
Quasi-Resonant (QR) vs. Active Clamp Flyback (ACF)





- High loss in RCD snubber circuit
- Partial hard switching at high line
- Losses increase with switching frequency

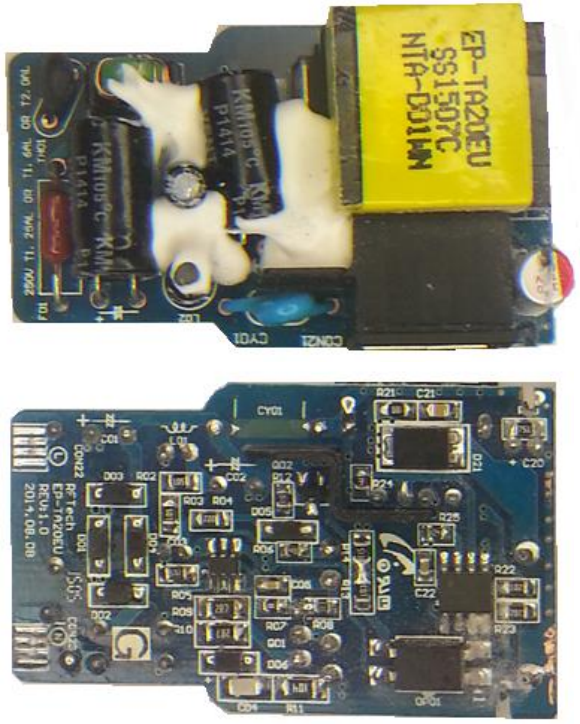




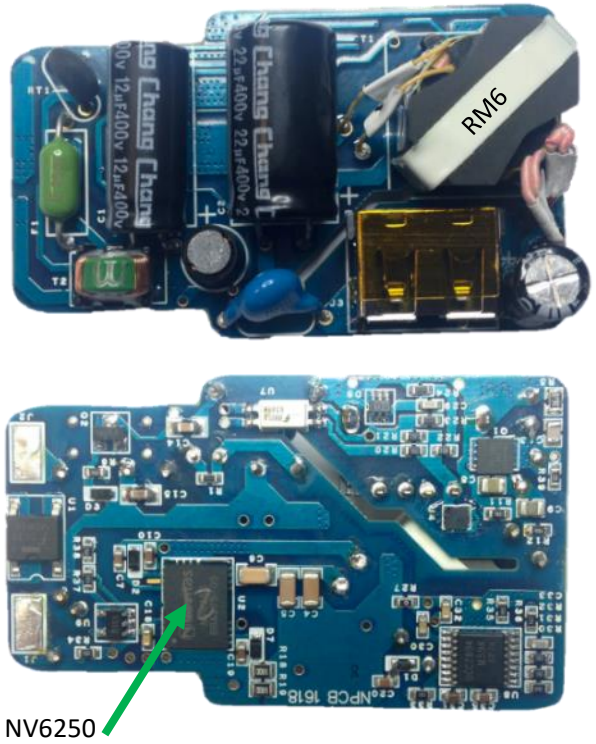
- No resistor needed in the snubber: no snubber loss
- Full range zero-voltage switching (ZVS): no switching loss
- ACF enables high switching frequency

25W ACF: 66% More Power

Original 15 W case

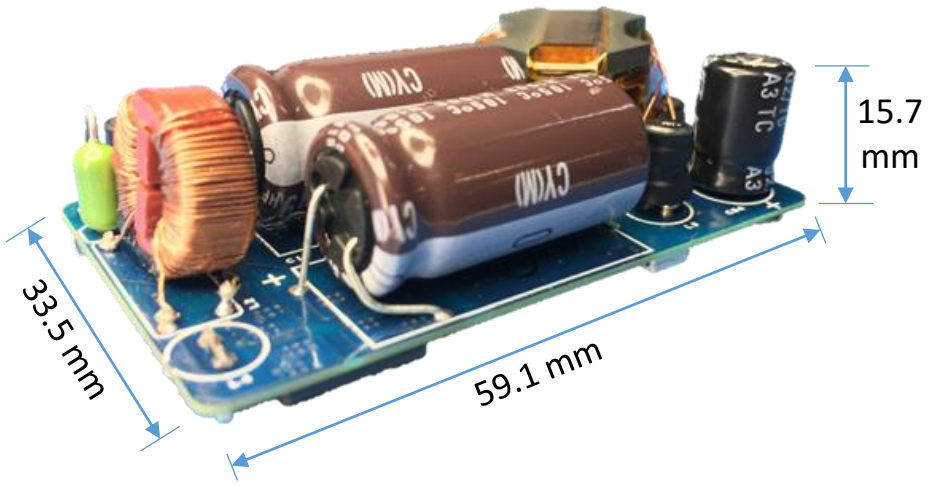


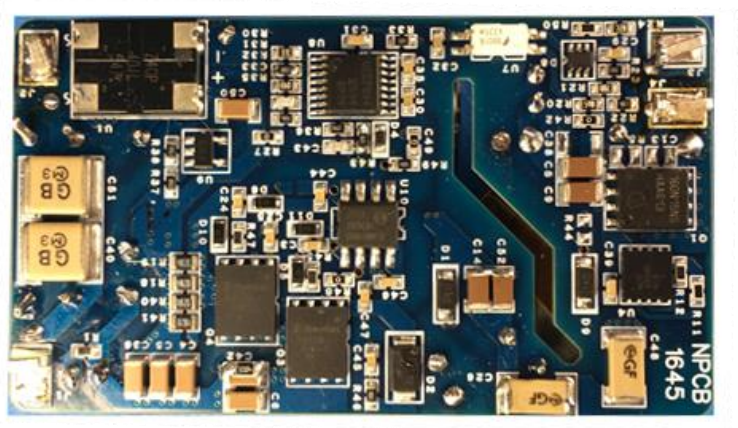
Original 15 W
Si-based QR Flyback
~100 kHz



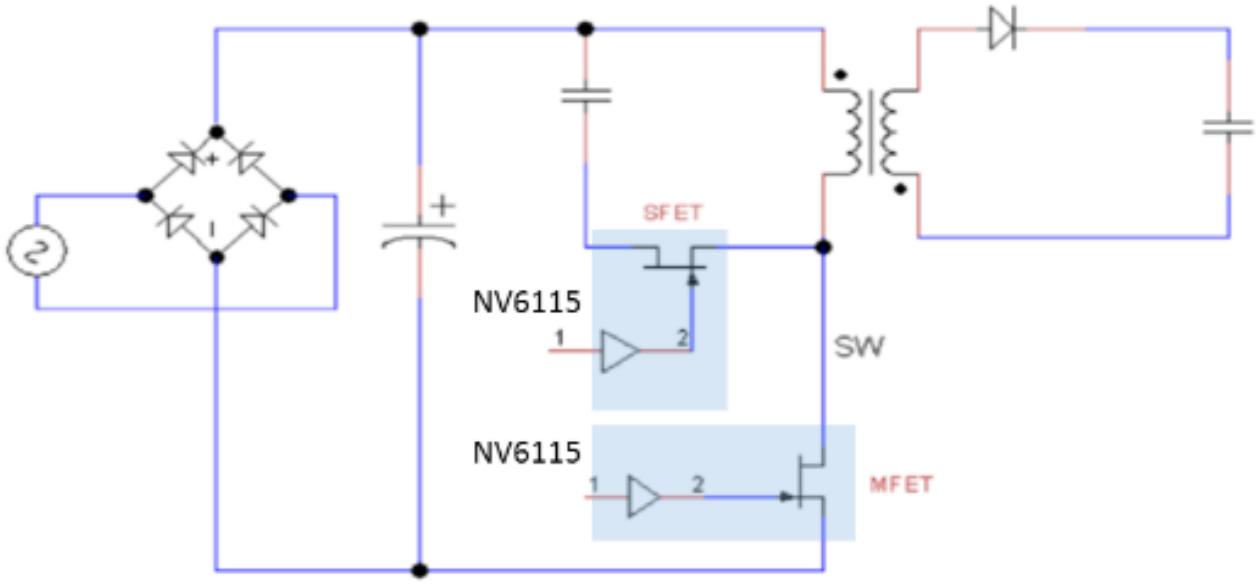
Upgraded 25 W
Half-Bridge GaN Power IC ACF
~400 kHz

45W ACF



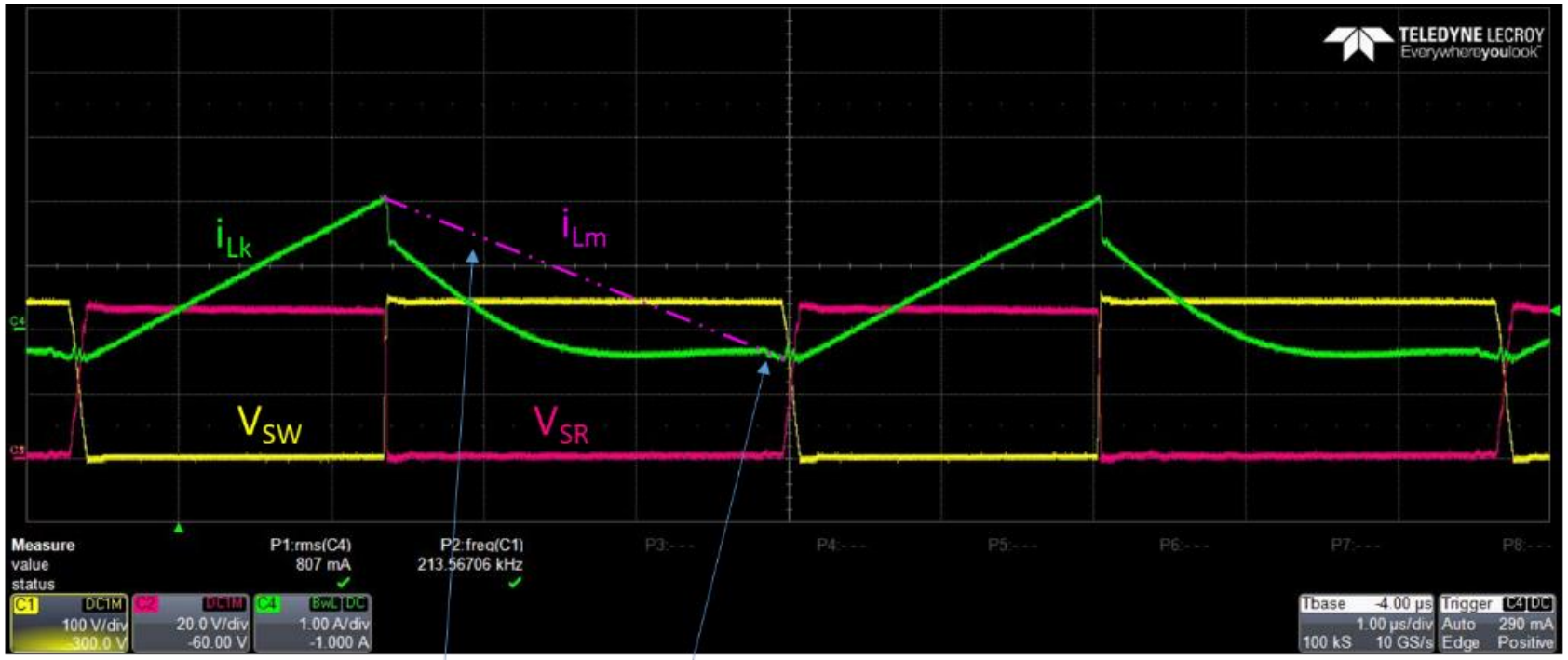


- 94.5% efficient at 220V (94.2% at $120V_{AC}$, 93.1% at $90V_{AC}$)
- 23.7 W/in^3 density (uncased)
- 15.7mm profile



For further details of ACF, please see APEC 2017 technical paper “Active Clamp Flyback Using GaN Power IC for Power Adapter Applications”, Xue, Zhang

45W CrCM ACF Operation

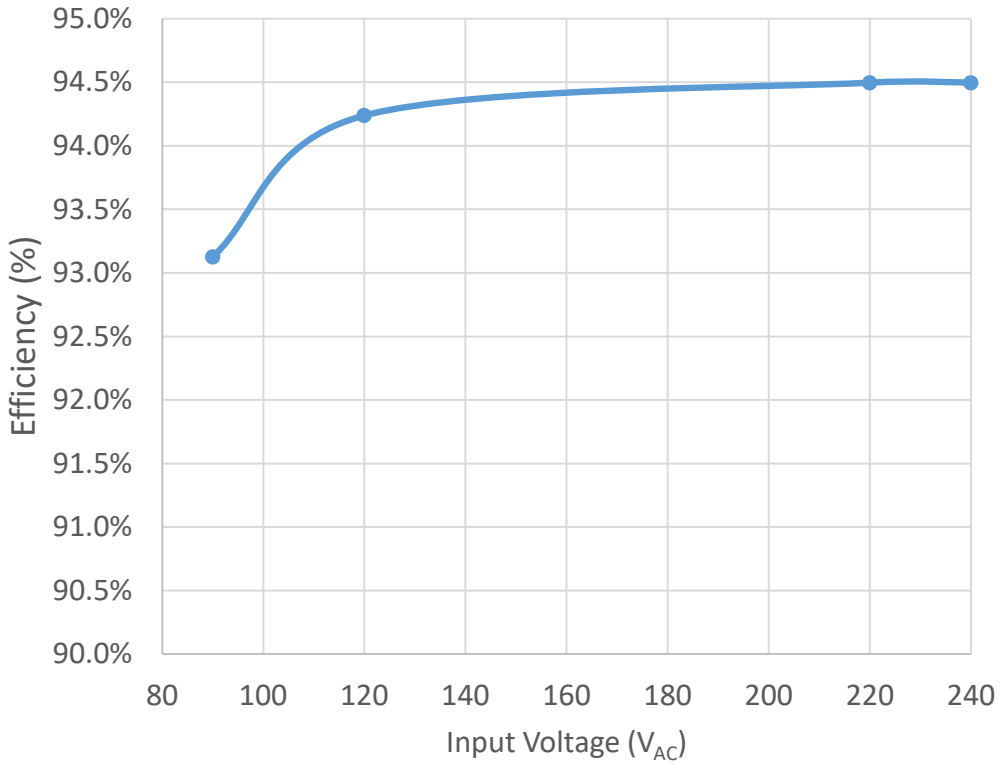


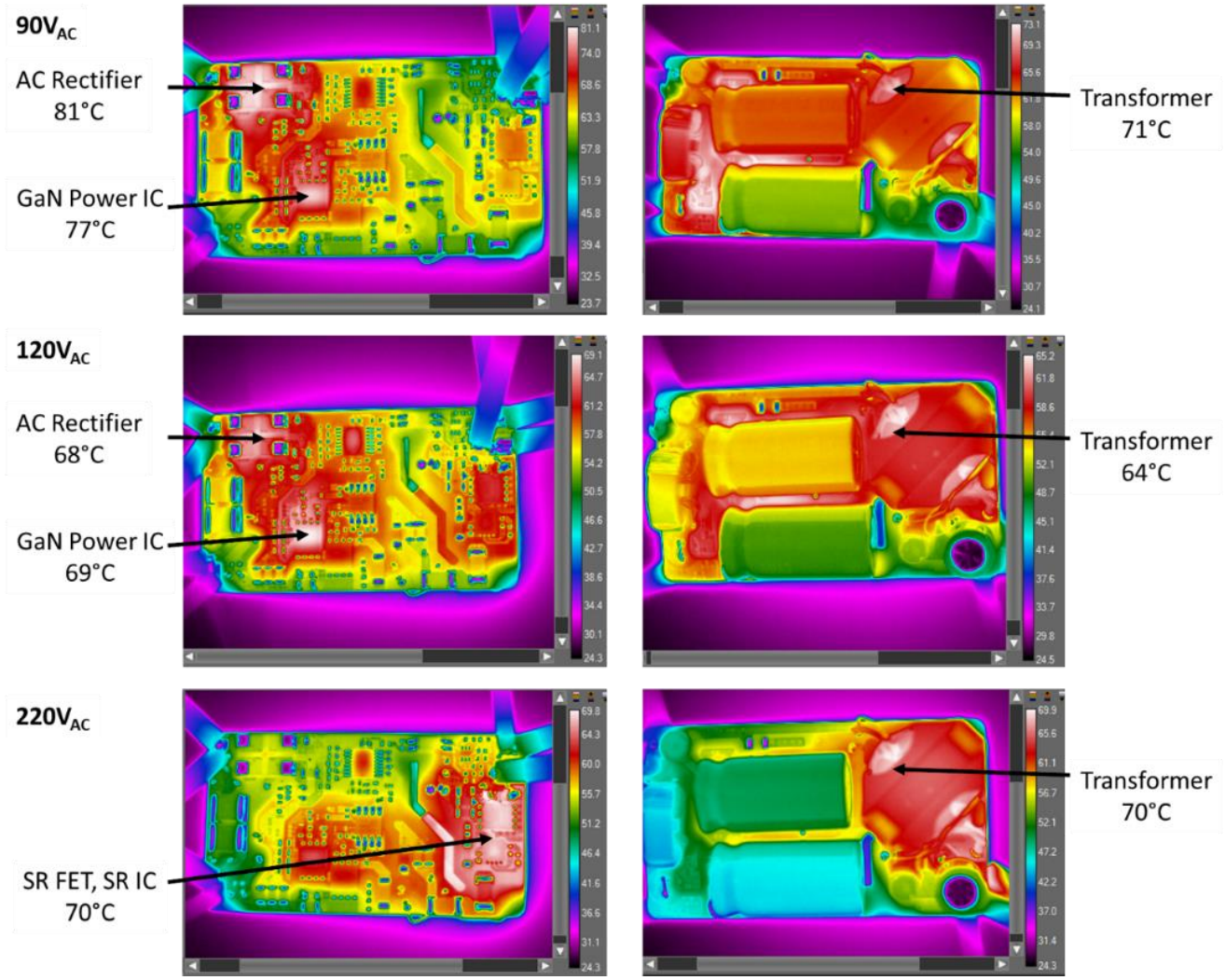
Magnetizing current (drawing)

Inductor current merges with magnetizing current, achieves SR ZCS turn-off

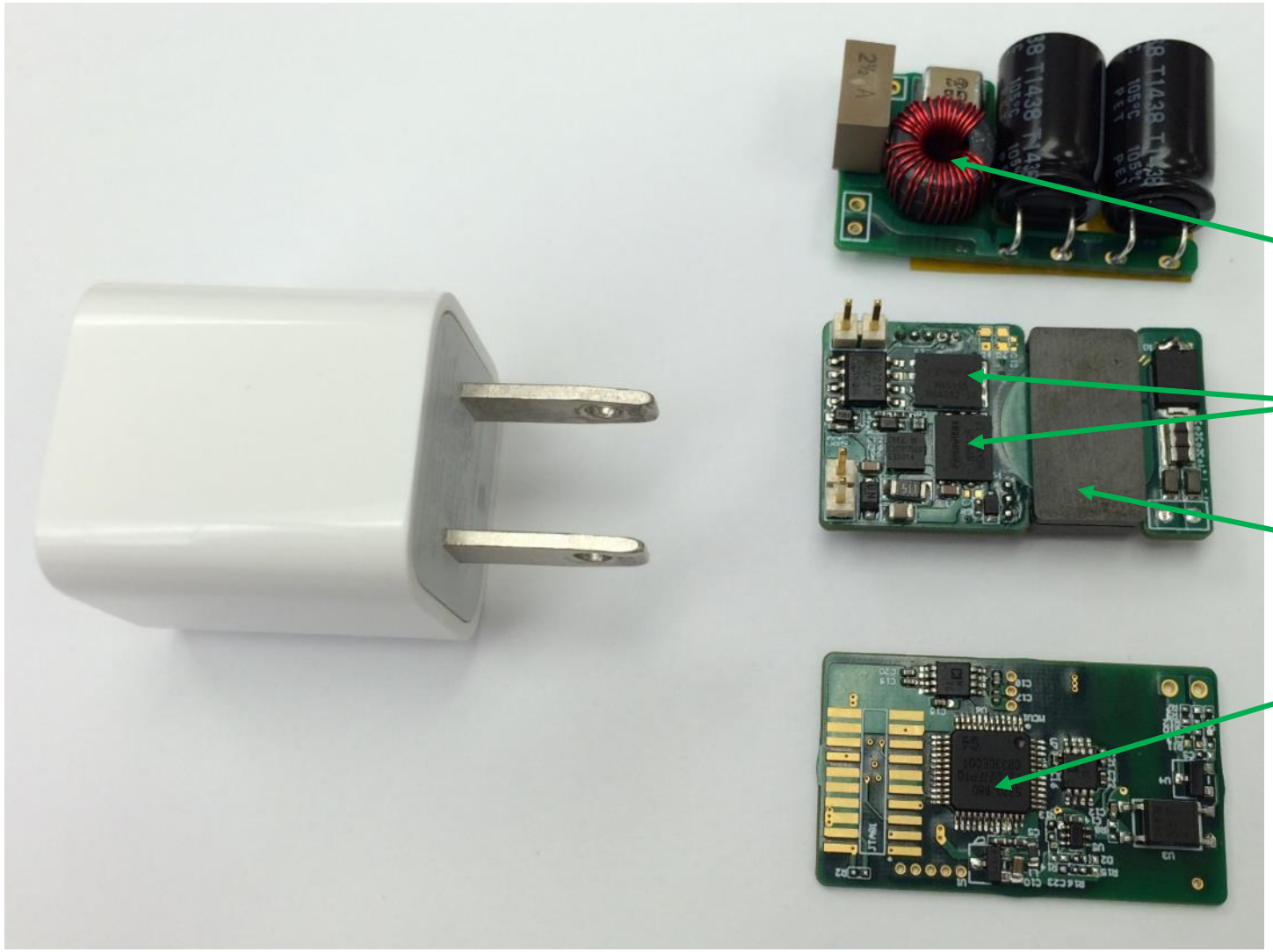
- Switch-node voltage (V_{SW}), SR FET voltage (V_{SR}), leakage current (i_{LK}) and magnetizing current (I_{Lm})
- 120V_{AC}, 0.2A load, F_{SW} = 210kHz

45W ACF: High Efficiency, Cool Temperatures





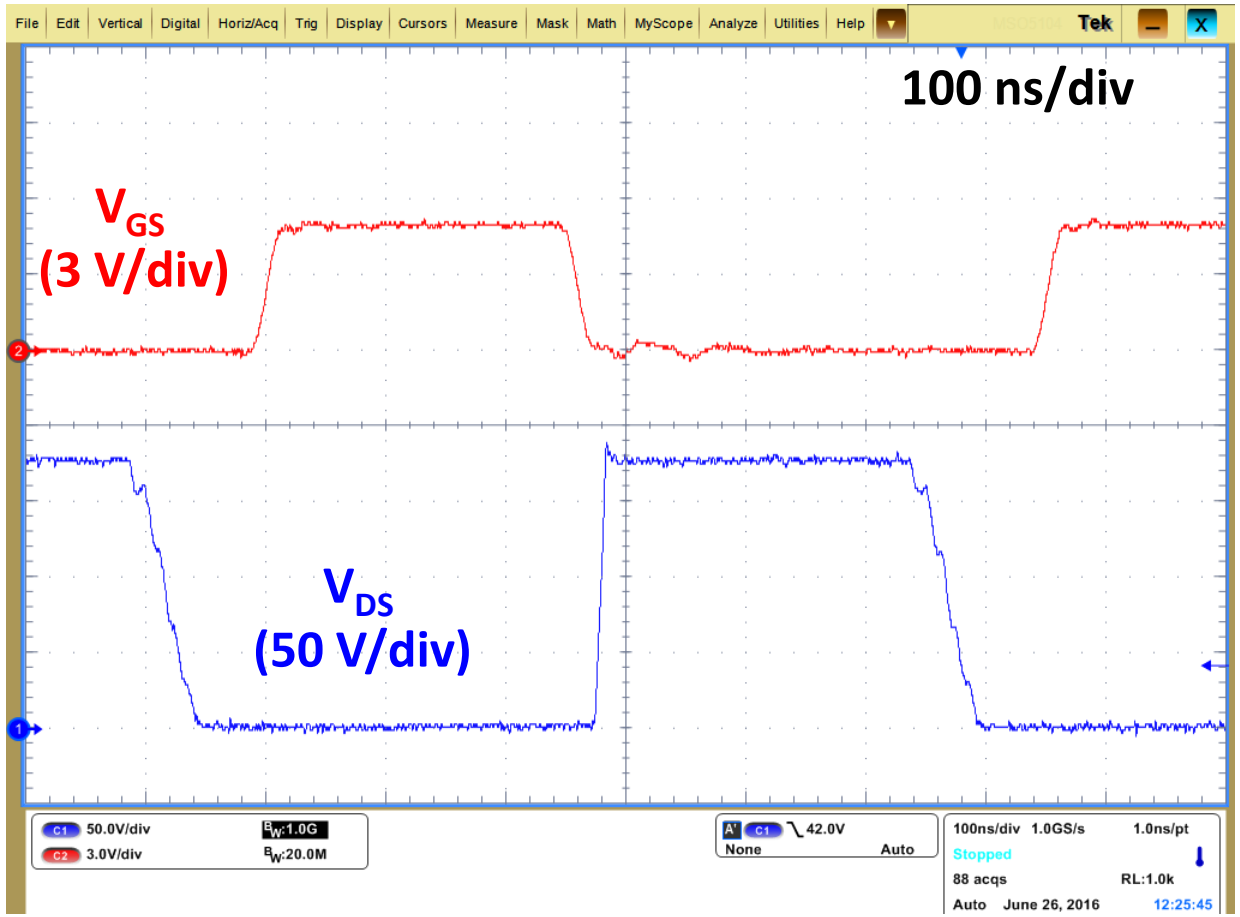
1 MHz, 25 W, 17 W/in3 (cased) ACF (CPES 2016)



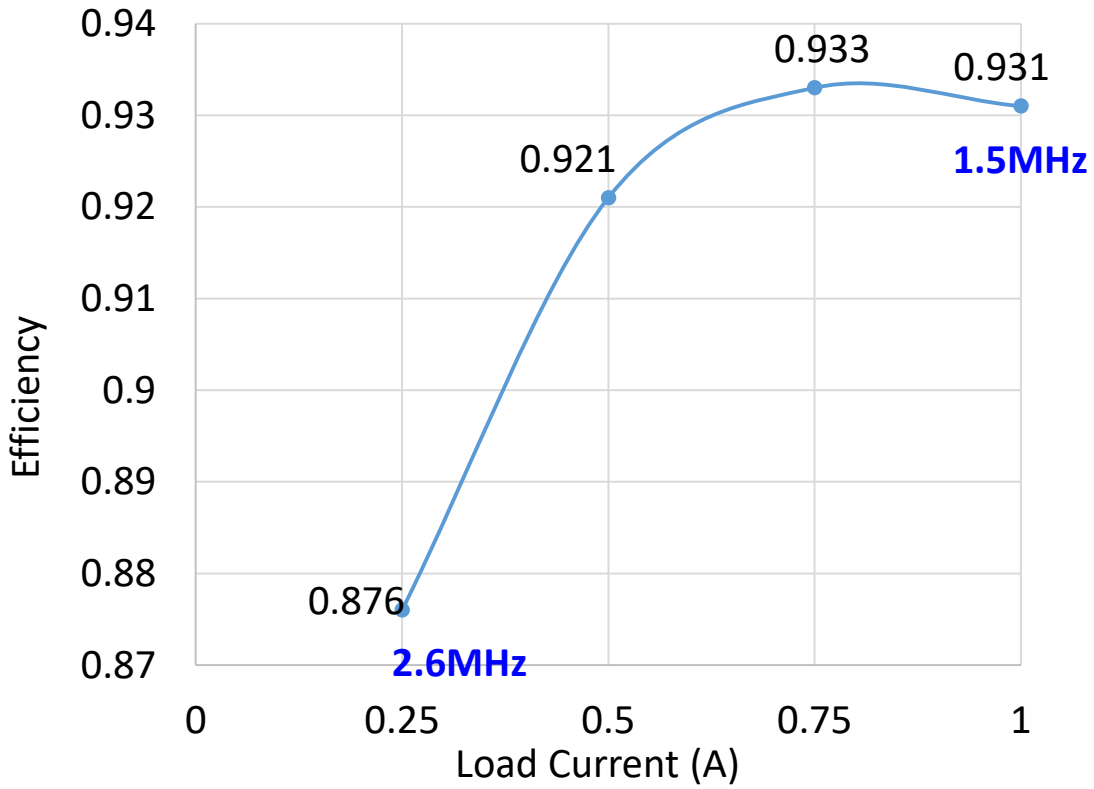
- Single-stage EMI
- Navitas GaN Power ICs
- Planar transformer
- DSP (for prototype)

MHz+ 25 W ACF

F_{SW}=1.5MHz



Efficiency vs. Load



** Exclude bridge and EMI filter loss*

GaN Power ICs enable Hi-Density Adapters

3x Higher Density with 50% Energy Savings

Navitas

Existing Si-based 150W	AllGaN™ 2016 150W	AllGaN™ 2017 150W
	*2x Higher Density* 	*3x Higher Density* 
100 kHz 5-10 W/in^3 88%	300-500 kHz 17 W/in^3 >93%	>1 MHz 26.5 W/in^3 >95%

Ultra-thin LED TV

All-in-One PCs

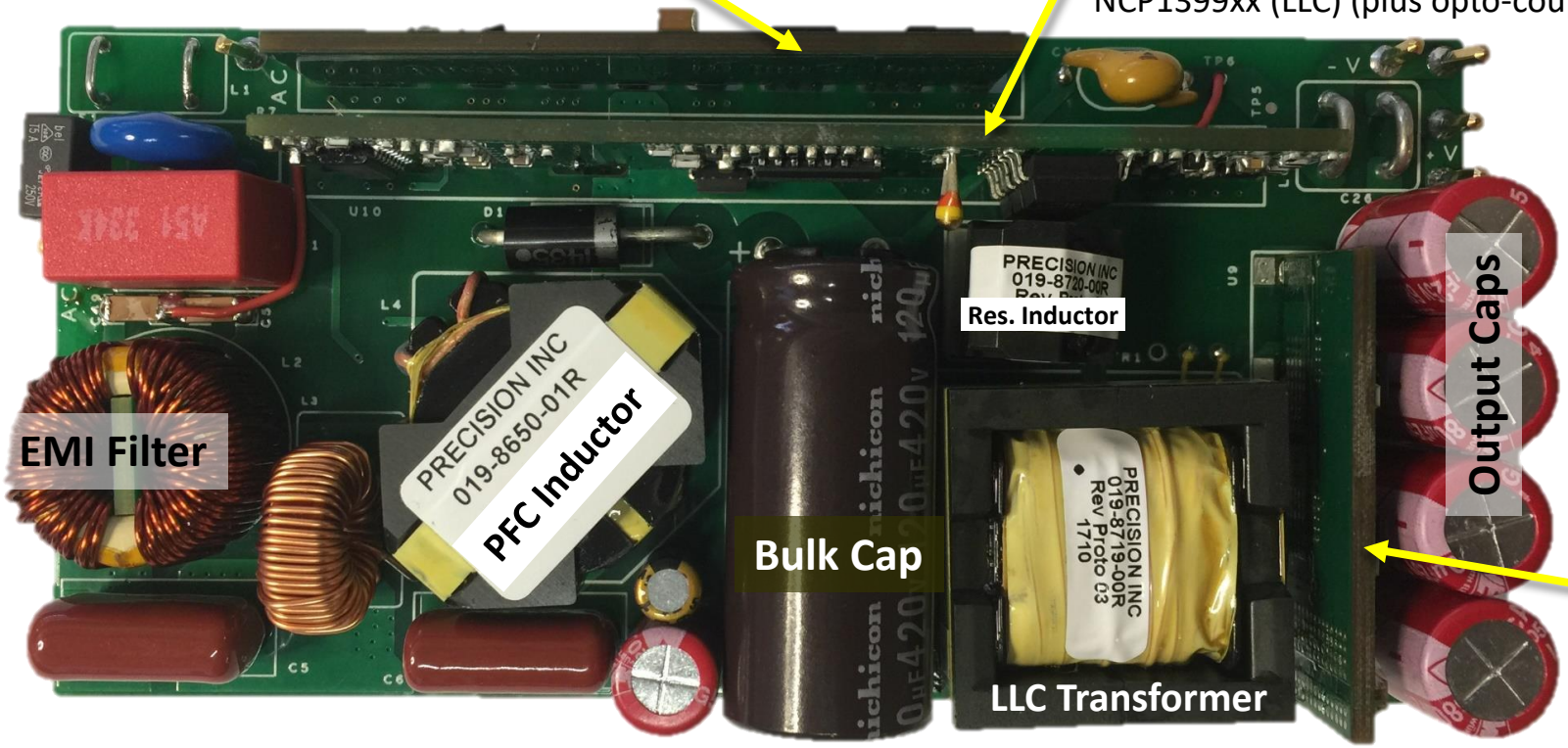
Next-Gen Gaming Consoles

2016: Navitas + On Semiconductor; **2017**: Xiucheng Huang, "High Frequency GaN Characterization and Design Considerations," Ph.D Dissertation, Dept. Electr. Eng., Virginia Tech., Blacksburg, VA, USA, 2016.

150W AC-19V

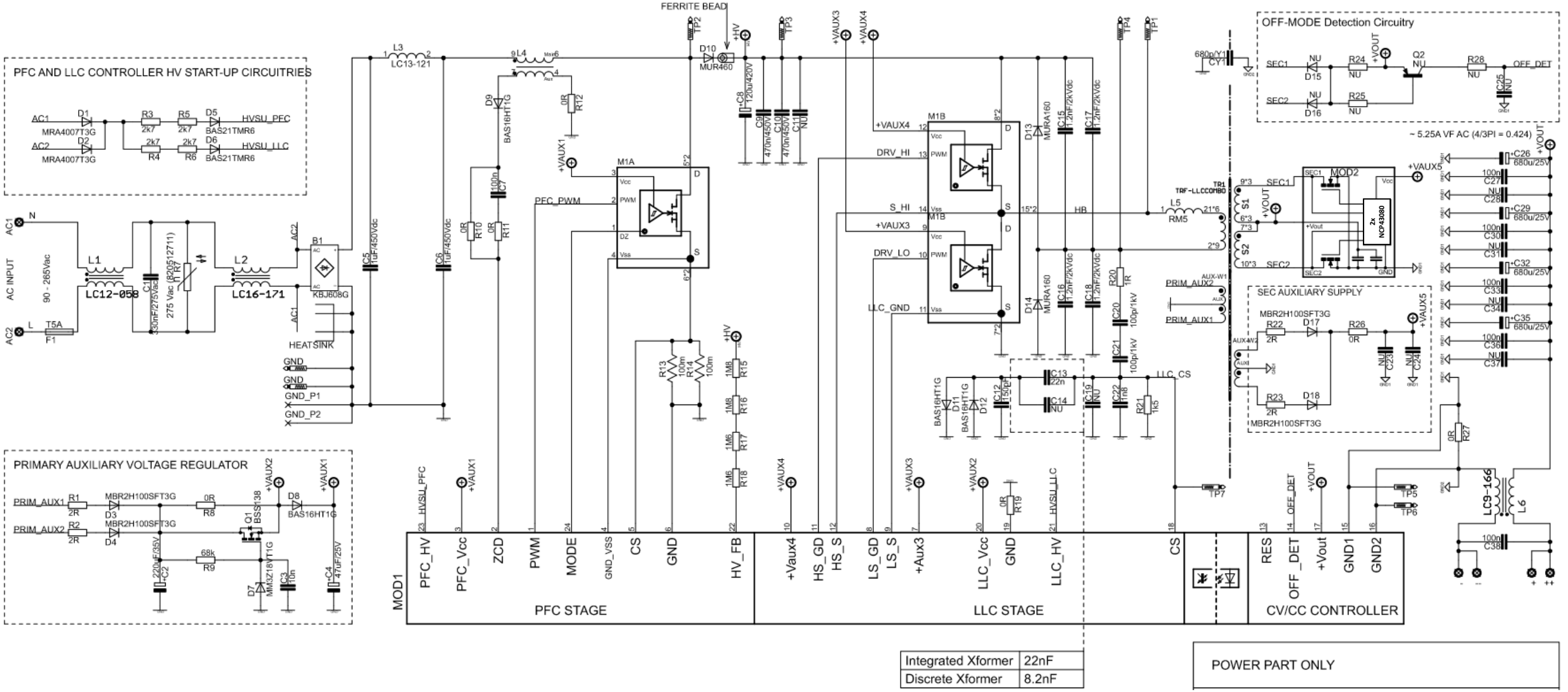
PFC + LLC Powertrain Daughtercard
NV6117 (PFC), 2x NV6115 (LLC)

PFC + LLC Control Daughtercard
NCP1615 (PFC)
NCP1399xx (LLC) (plus opto-couplers)

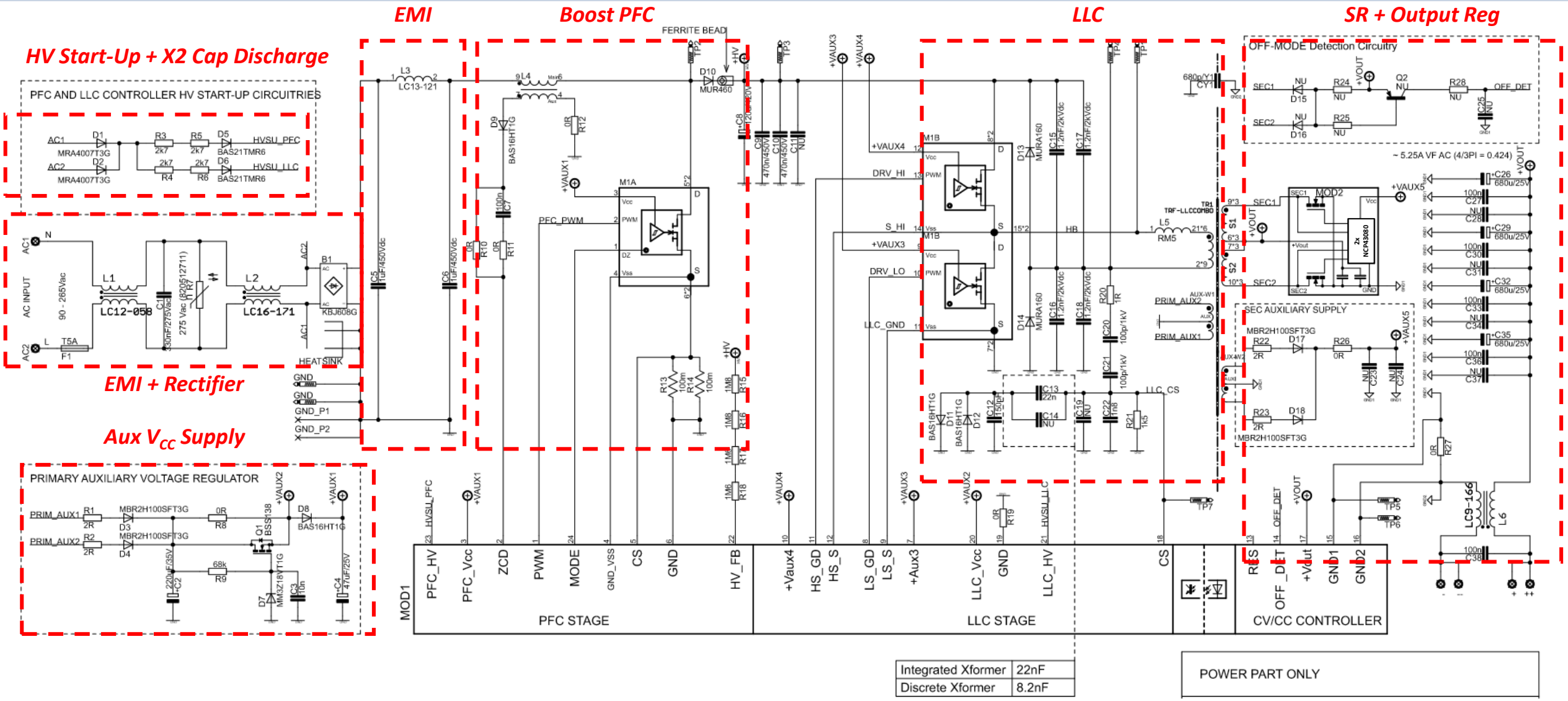


SR Daughtercard:
2x NCP43080
2x NVMFS5C628NL

Schematics (Complete Board)

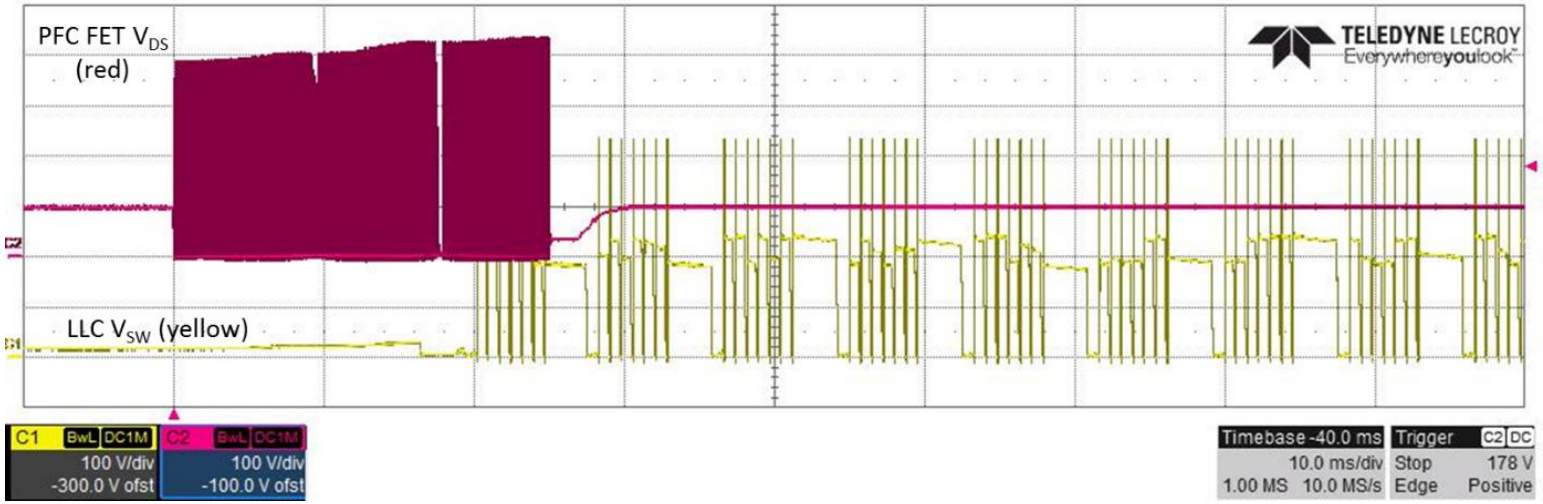


Schematics (Complete Board)

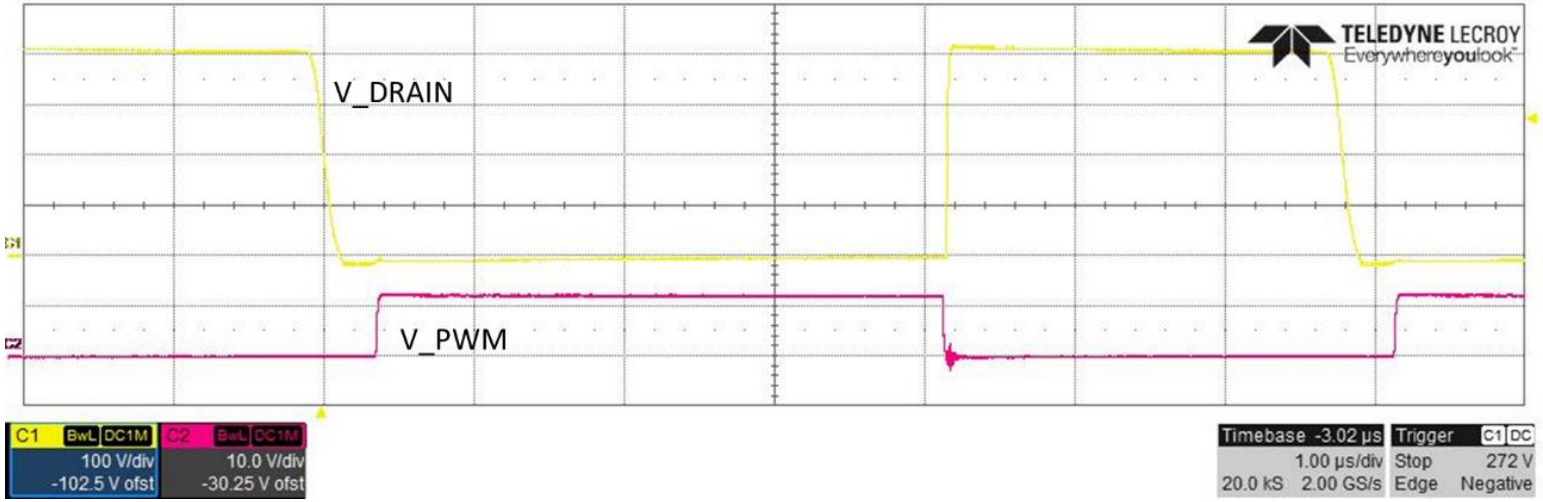


PFC Waveforms

PFC FET V_{DS}, LLC V_{SW} at start-up

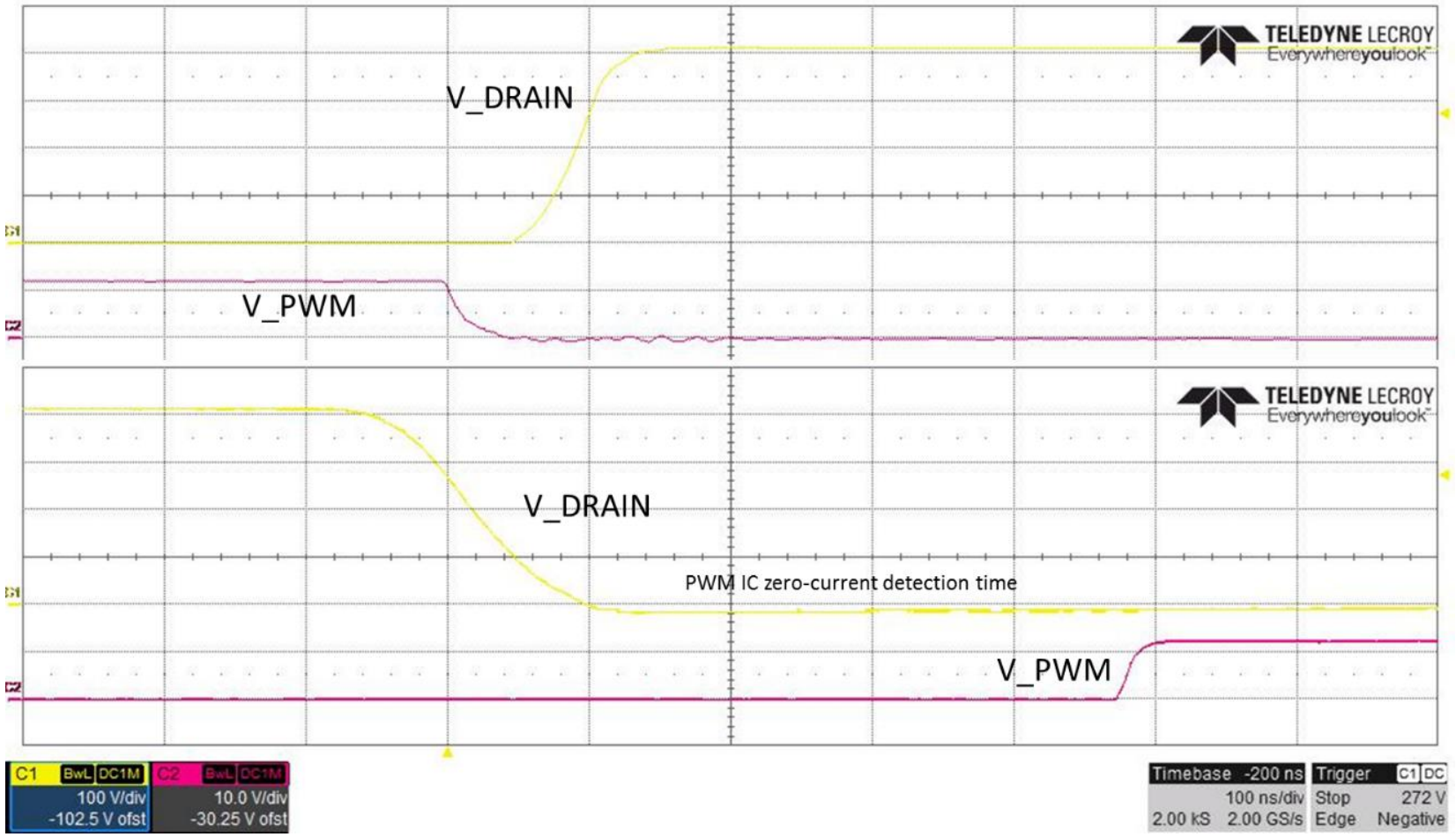


PFC switching (zoom), 220V_{AC}, 150W

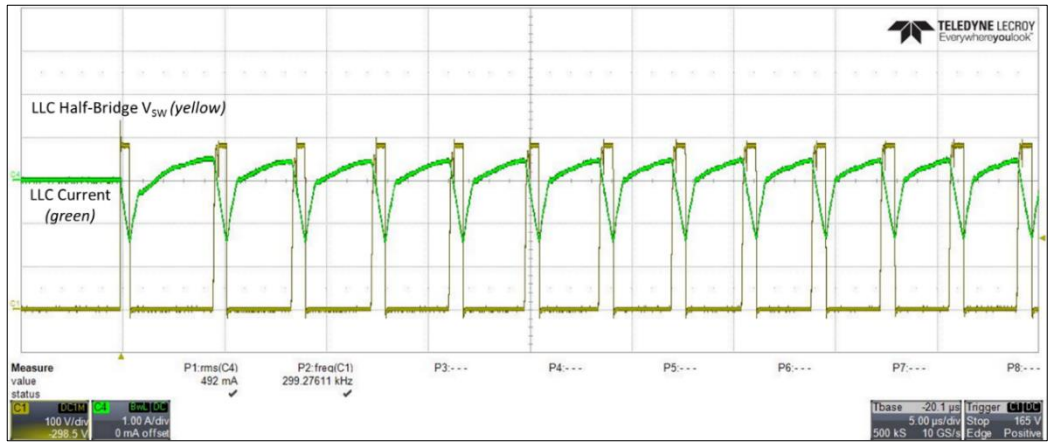


PFC Waveforms

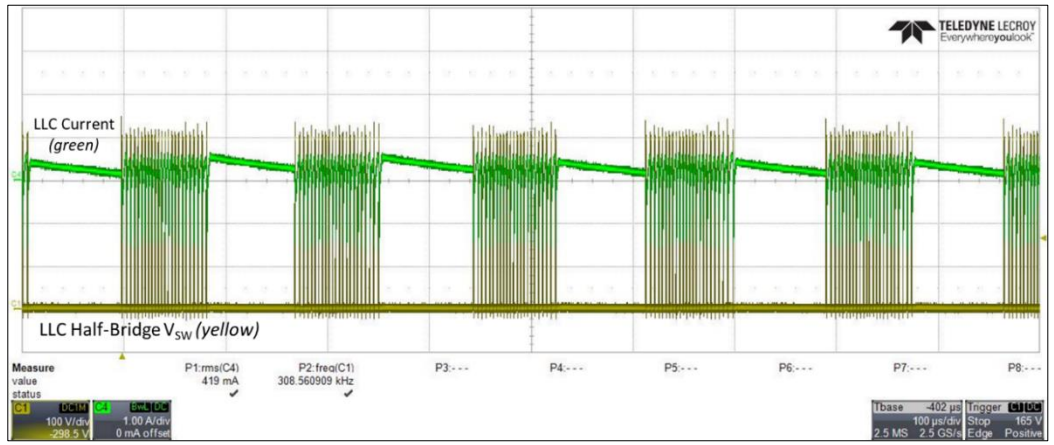
PFC switching (zoom), $220V_{AC}$, 150W



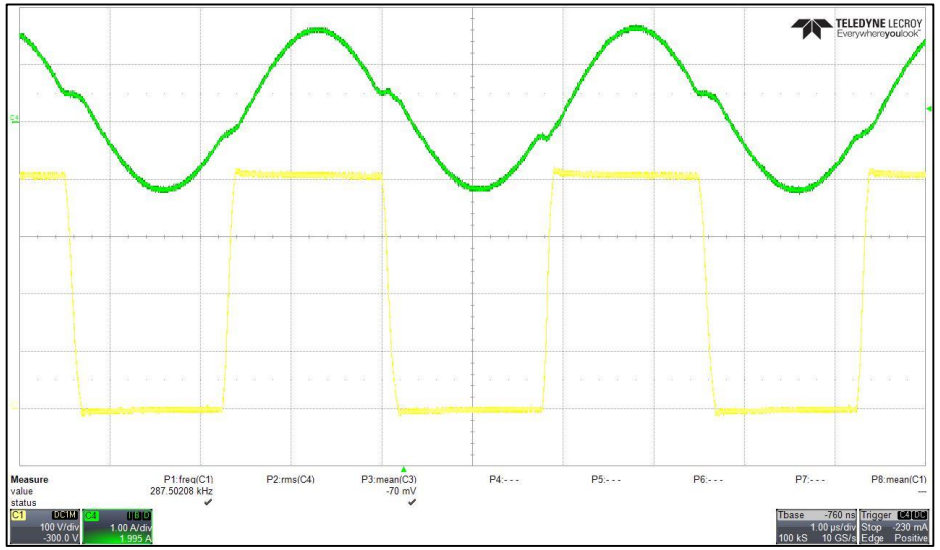
LLC Waveforms



LLC V_{SW}, open load, $19V_{OUT}$

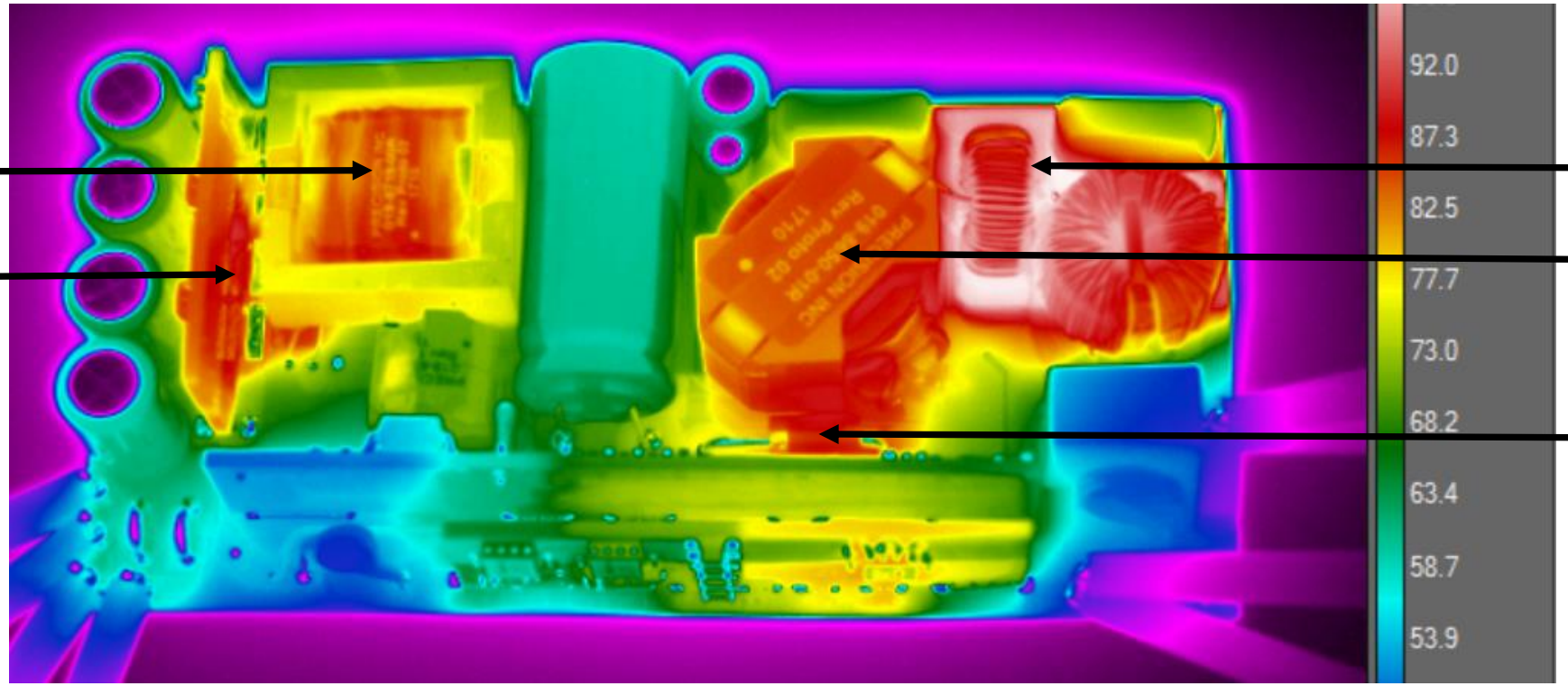


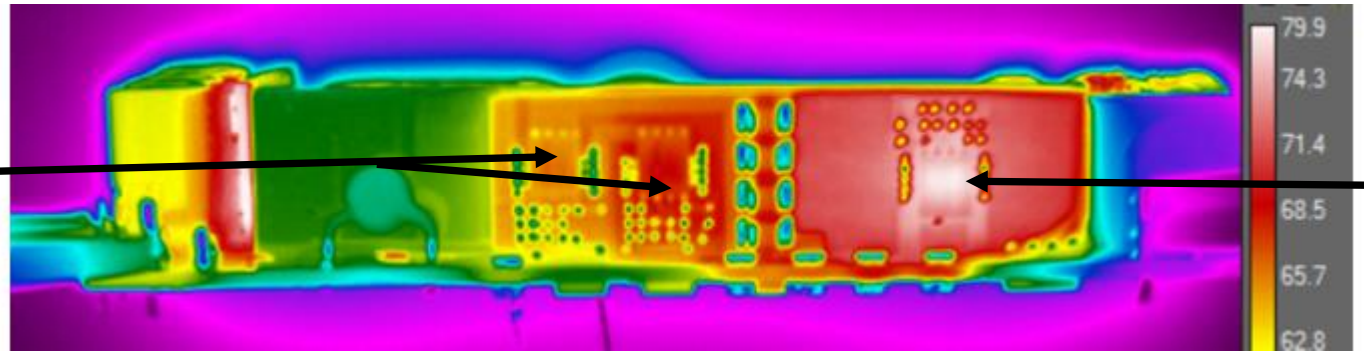
LLC V_{SW}, skip-mode, $19V_{OUT,}$ 1A



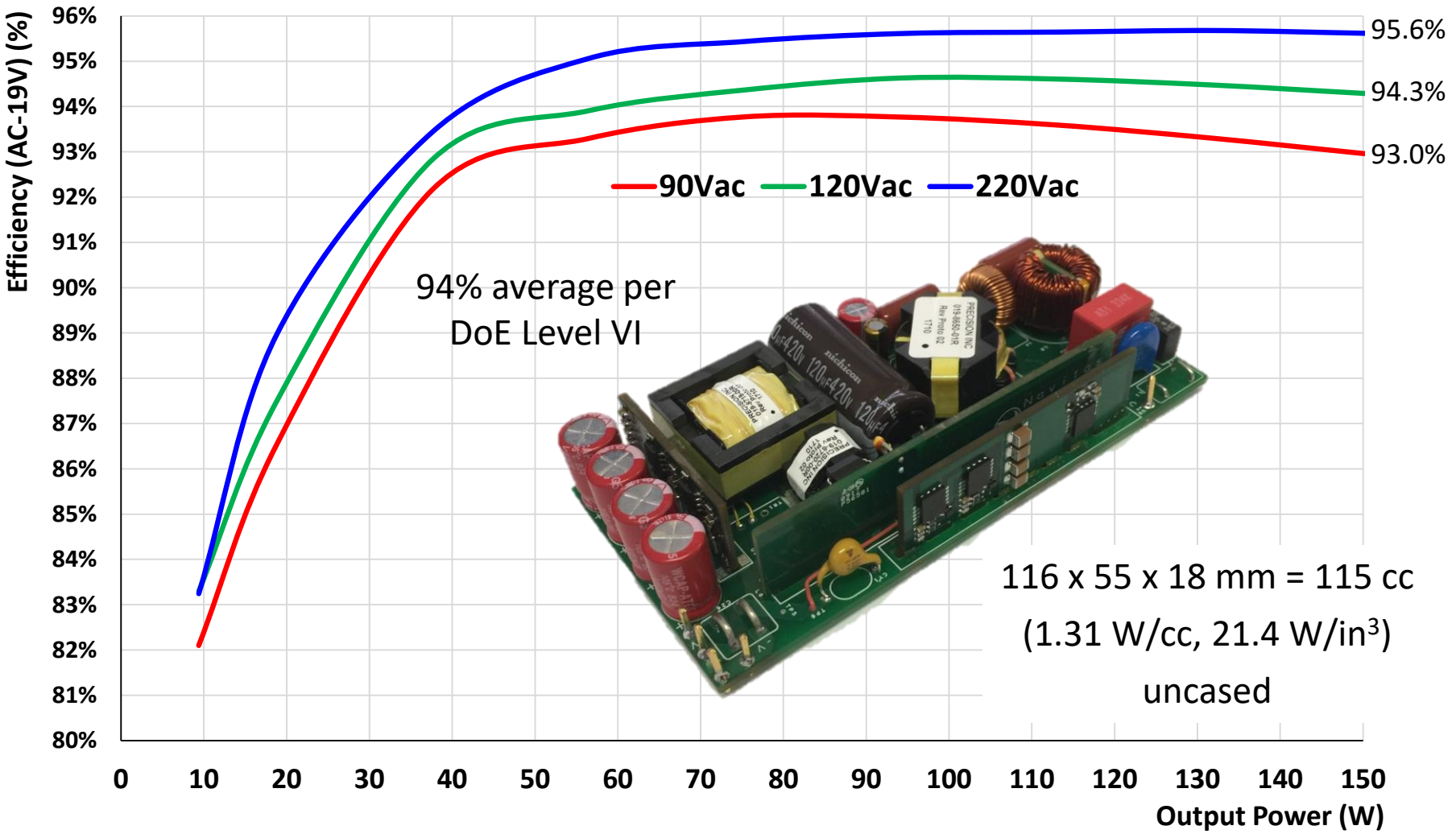
LLC V_{SW}, I_L, $19V_{OUT}$, 8A

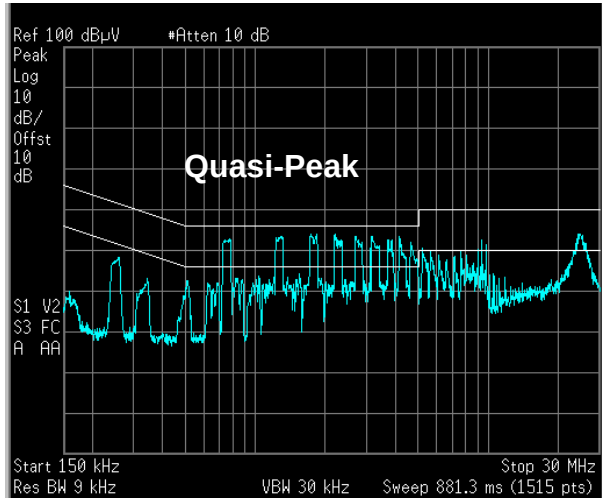
150W: Running Cool

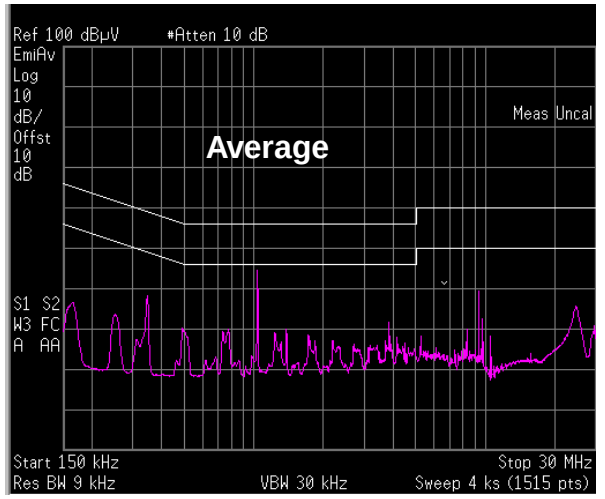




150W AC-19V, ~300 kHz

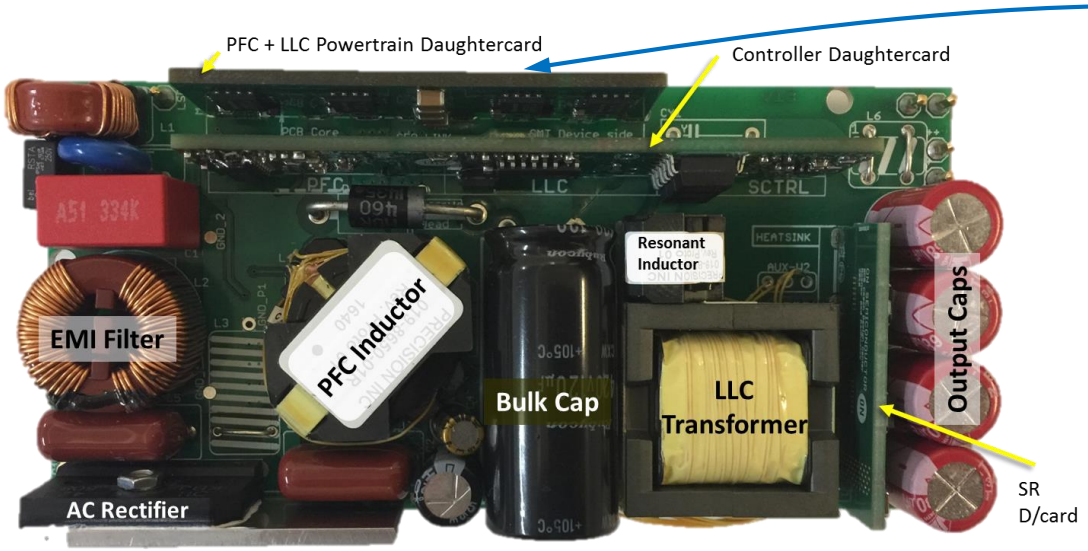


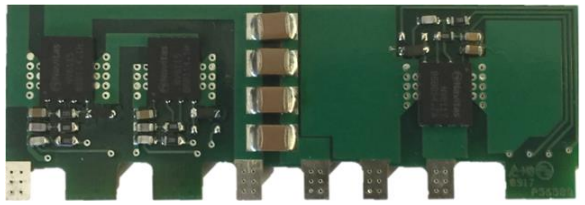




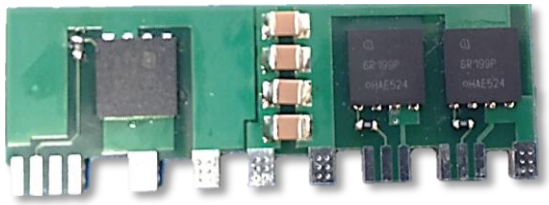
150W, 19V: GaN Power IC vs. Si

Part#	Technology	V	Pack	$R_{DS(ON)}$ (typ. mΩ)	Q_G (typ. nC)	C_{OSS}(er) (typ. pF)	R x Q_G (mΩ.nC)	R x C_{OSS}(er) (mΩ.pF)
STL34N65M5	Si FET	650	8x8	99	62.5	63	6,187	6,237
IPL60R199CP	Si FET	600	8x8	180	32	69	5,760	12,420
IPL60R299CP	Si FET	600	8x8	270	22	46	5,940	12,420
NV6115	GaN Power IC	650	5x6	160	2.5	30	400	4,800
NV6117	GaN Power IC	650	5x6	110	4	45	440	4,950
GaN Benefit							***14x***	***1.5-2.5x***





Navitas GaN Power ICs (5x6mm QFN)
PFC = 1x NV6117, LLC = 2x NV6115



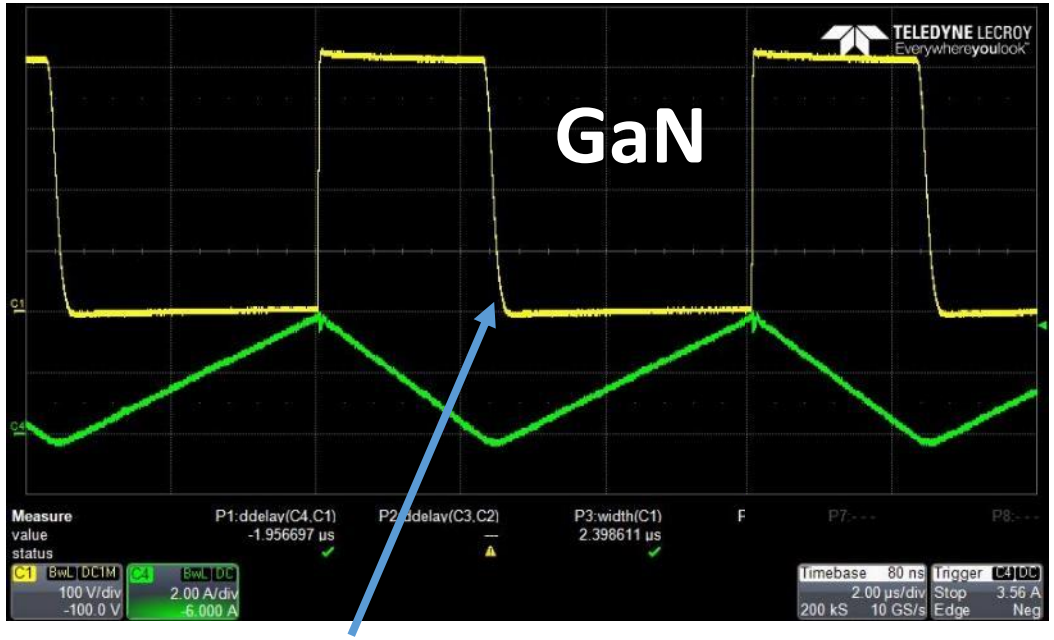
Si FETs (8x8mm QFN)
a) PFC = 1x IPL60R299CP, LLC = 2x IPL60R299CP
b) PFC = 1x IPL60R199CP, LLC = 2x IPL60R299CP

For further details of the 150 W, 21 W/in3 board, please see APEC 2017 Industry Session "State-of-the-Art Mobile Charging: Topologies, Technologies and Performance" (Mobile Applications)

Si Starts Hard Switching as Frequency Increases

120V_{AC}, Si CP partial hard-switching (~200kHz)

- Voltage spikes
- Partial hard-switching (loss)



120V_{AC}, GaN clean ZVS waveforms (~200kHz)

- No voltage spikes / overshoot
- Clean ZVS turn-on transition
- Minimize deadtime for low reverse conduction loss

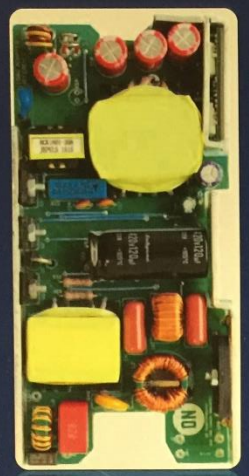
GaN vs. Si

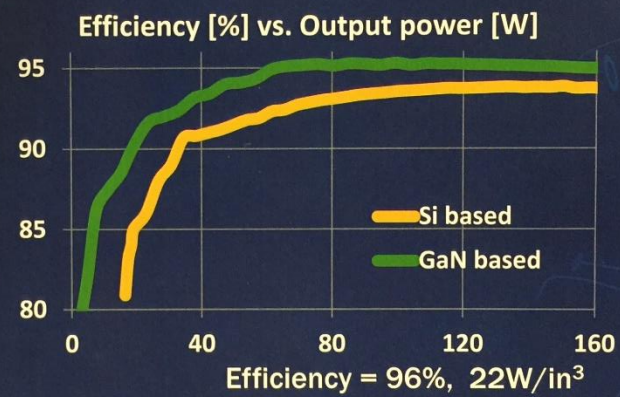
High Power Density and High Switching Frequency Adapter

- Ultra high-power density up to 22 W/ in^3
- Very high Efficiency up to 96 % with GaN Power FETs
- The smallest dimensions 4.6 x 1.96 x 0.78 in
- Performance ensured by NCP1399, NCP1615, NCP43080
- Up to 94 % Efficiency with Silicon Super-Junction MOSFETs

Typical applications

- High Power Laptop Adaptors, Power supplies, Power chargers
- 150 W Output Power @ 19 V with ~8.5 A current limit





Efficiency = 96%, 22W/in^3

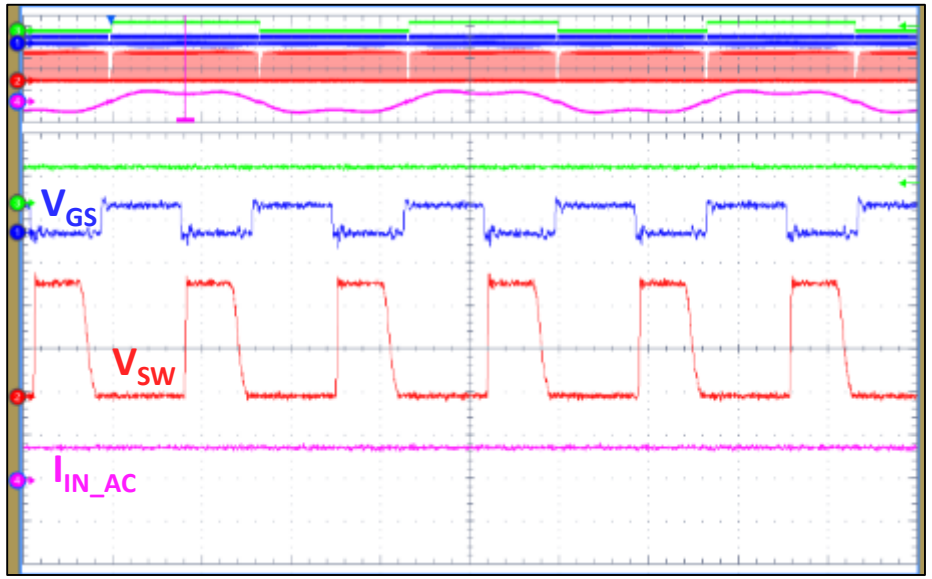
Efficiency = 94%, 13W/in^3

Higher switching frequency enables:

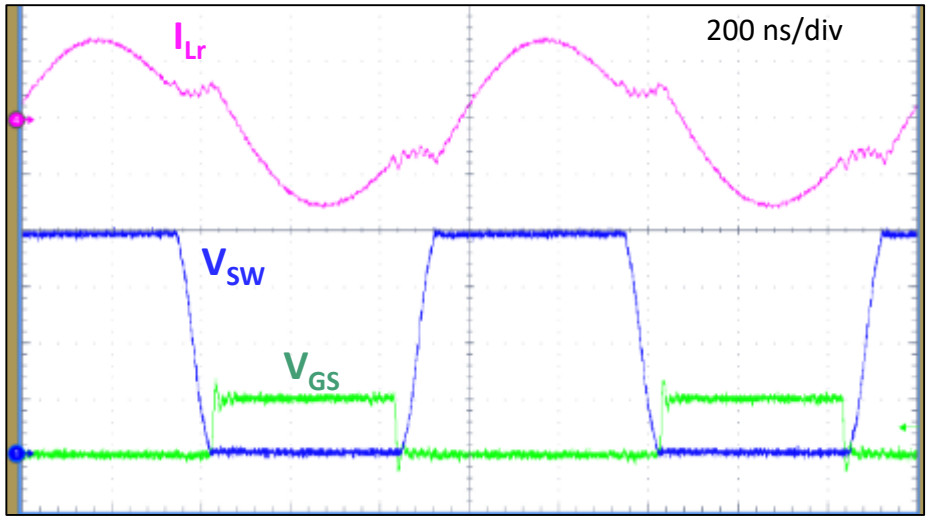
- Up to 40% volume reduction, Power Density almost doubled
- Compact design / balanced price
- Keep high efficiency

MHz 150W Totem-pole + LLC (CPES 2016)

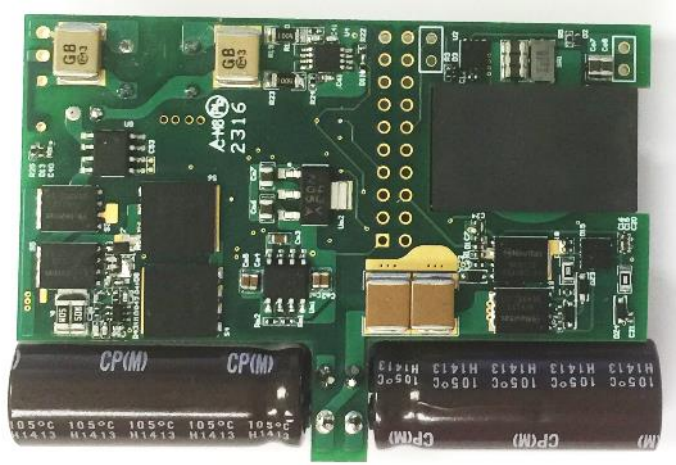
PFC

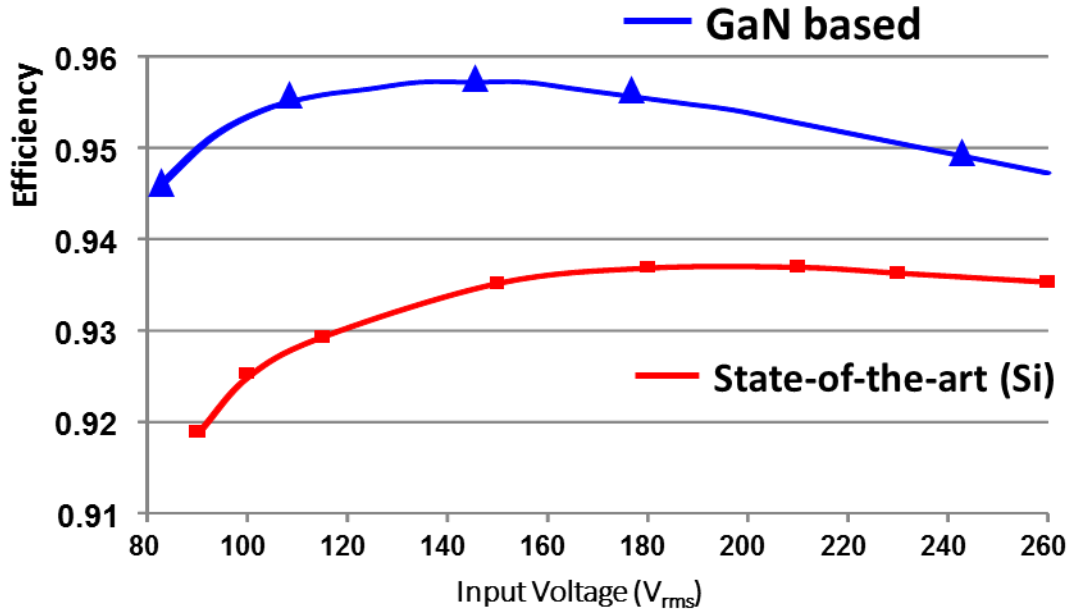


LLC



GaN-based
Power Density
= 35 W/in^3
(uncased)





Pop Quiz! How do we shrink our power supplies?

A. Select the right ZVS topology
B. Increase switching frequency
C. Select the right magnetic material
D. Select the right GaN Power IC
E. Increase efficiency
F. <u>All of the above</u>
G. None of the above…
…use hard-switching topologies and Silicon switching < 100kHz.